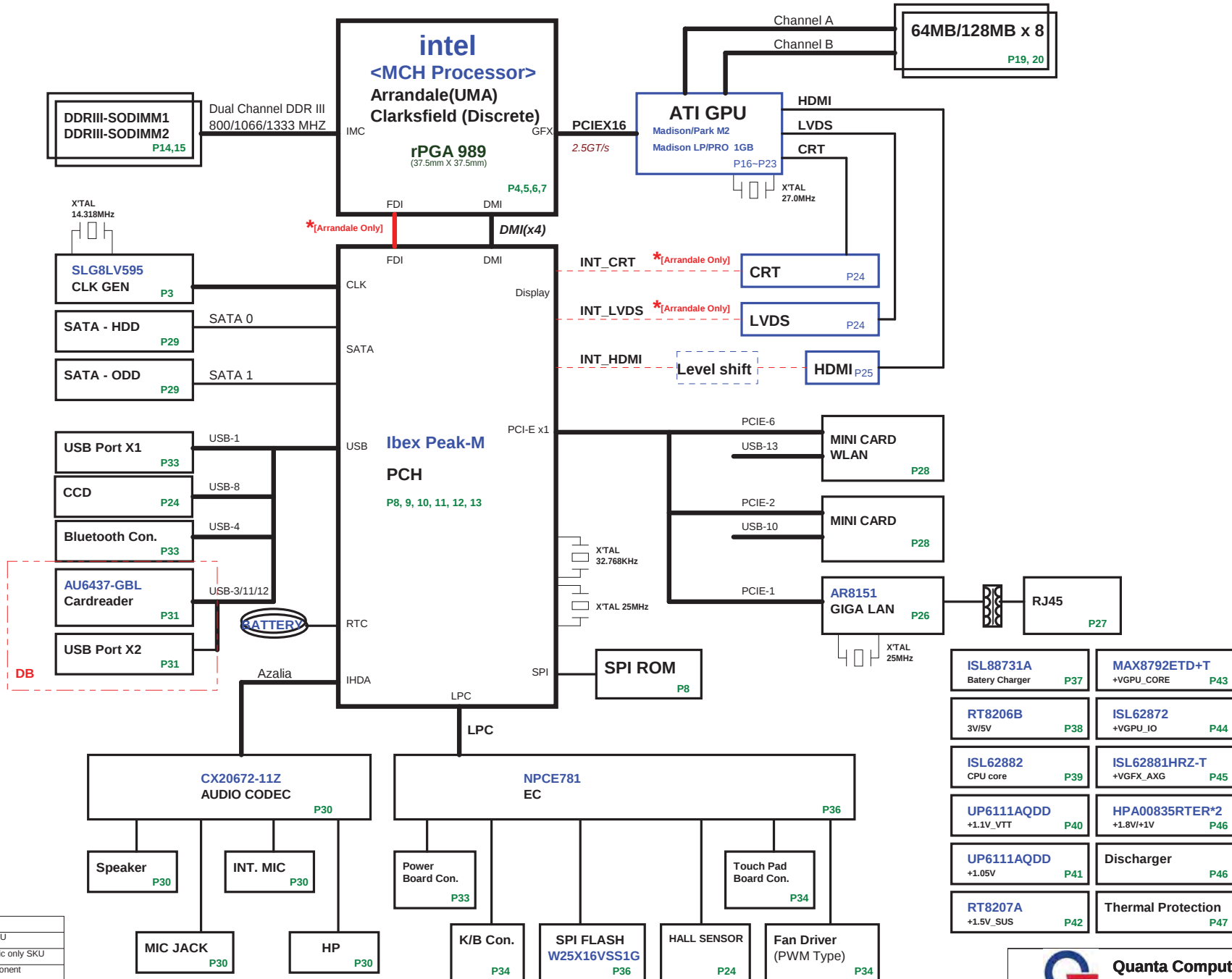


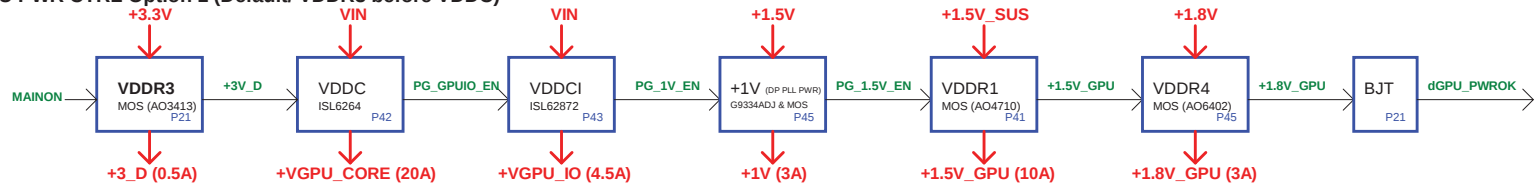
ZYD SYSTEM BLOCK DIAGRAM



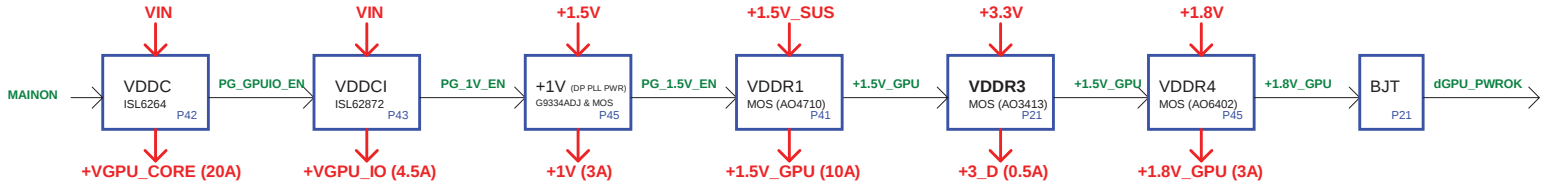
BOM Option Table

Reference	Description
IV@	for UMA only SKU
EV@	for Discrete Graphic only SKU
SP@	special case component
*	do not stuff

GPU PWR CTRL Option 1 (Default/ VDDR3 before VDDC)



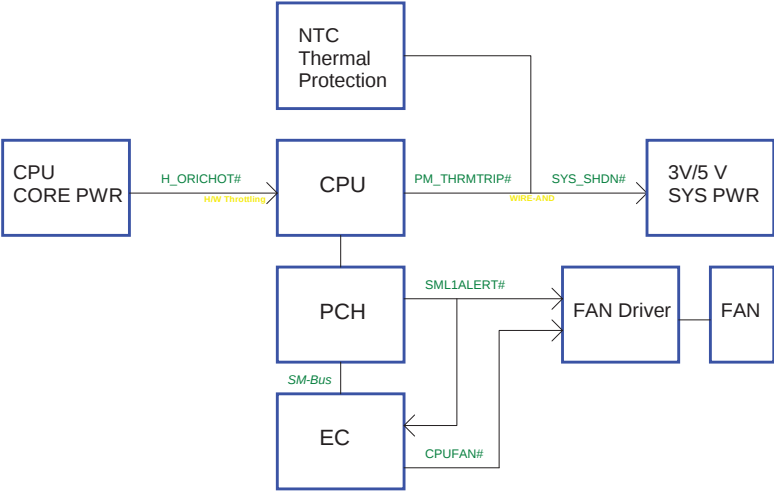
GPU PWR CTRL Option 2 (VDDR3 after VDDR1)

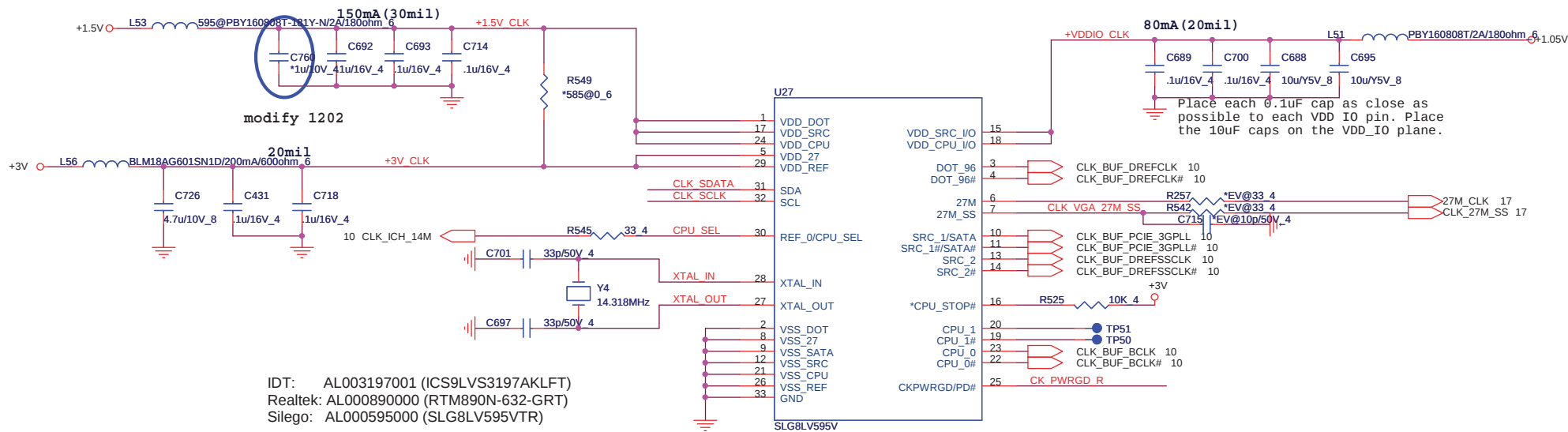


Power States

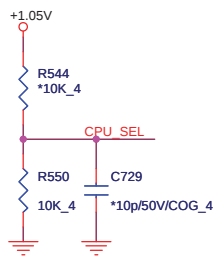
POWER PLANE	VOLTAGE	DESCRIPTION	CONTROL SIGNAL	ACTIVE IN
VIN	+10V--+19V	MAIN POWER	ALWAYS	ALWAYS
+VCCRTC	+3V--+3.3V	RTC POWER	ALWAYS	ALWAYS
+3VPCU	+3.3V	EC POWER	ALWAYS	ALWAYS
+5VPCU	+5V	CHARGE POWER	ALWAYS	ALWAYS
+15V	+15V	CHARGE PUMP POWER	ALWAYS	ALWAYS
+3V_S5	+3.3V	LAN/BT/PCH	S5_ON	S0-S5
+5V_S5	+5V	USB POWER	S5_ON	S0-S5
+5V	+5V	HDD/ODD/Codec/TP/CRT	MAINON	S0
+3V	+3.3V	CLK GEN/PCH/GPU/LVDS/Mini card/Codec/card MAINON	MAINON	S0
+1.5V_SUS	+1.5V	CPU/SODIMM CORE POWER	SUSON	S0-S3
+0.75V_DDR_VTT	+0.75V	SODIMM Termination POWER	MAINON	S0
+VGFX_AXG	variation	Internal GPU POWER	GFX_ON	S0
+1.8V	+1.8V	CPU/PCH/Braidwood POWER	MAINON	S0
+1.5V	+1.5V	MINI CARD/NEW CARD POWER	MAINON	S0
+1.1V_VTT	+1.05V or +1.1V	CPU VTT POWER	MAINON	S0
+1.05V	+1.05V	PCH CORE POWER	MAINON	S0
+VCC_CORE	variation	CPU CORE POWER	VRON	S0
LCDVCC	+3.3V	LCD POWER	LVDS_VDDEN	S0
+5V_GPU	+5V	SWITCHABLE PWM IC POWER	dGPU_PWR_EN#	Discrete enable
+3V_D	+3.3V	I/O POWER for 3.3V pins	dGPU_VRON	Discrete enable
+VGPU_CORE	+0.9V--+1.1V	GPU CORE POWER	+3V_D	Discrete enable
+VGPU_IO	+0.9V--+1.1V	GPU I/O POWER	PG_GPUIO_EN	Discrete enable
+1V	+1V	DP/PEG POWER	PG_1V_EN	Discrete enable
+1.5V_GPU	+1.5V	VRAM CORE POWER	PG_1.5V_EN	Discrete enable
+1.8V_GPU	+1.8V	GPU_CRE/LVDS/PLL POWER	+1.5V_GPU	Discrete enable

Thermal Follow Chart



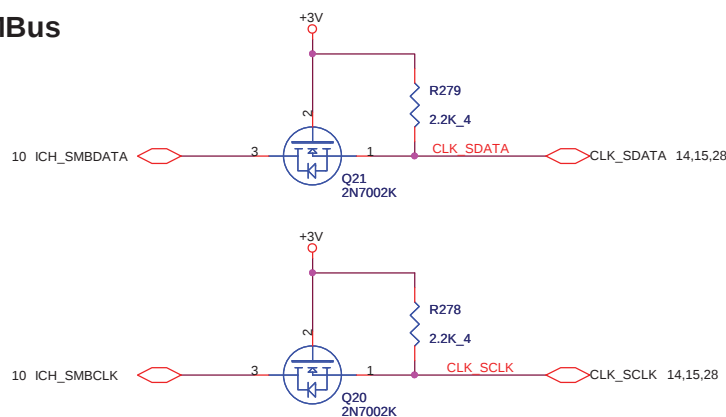


CPU_CLK select

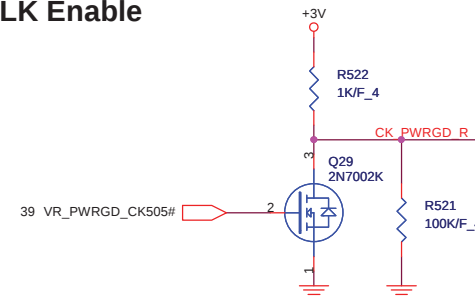


	0	1
CPU_SEL	CPU0/1=133MHz (default)	CPU0/1=100MHz

SMBus

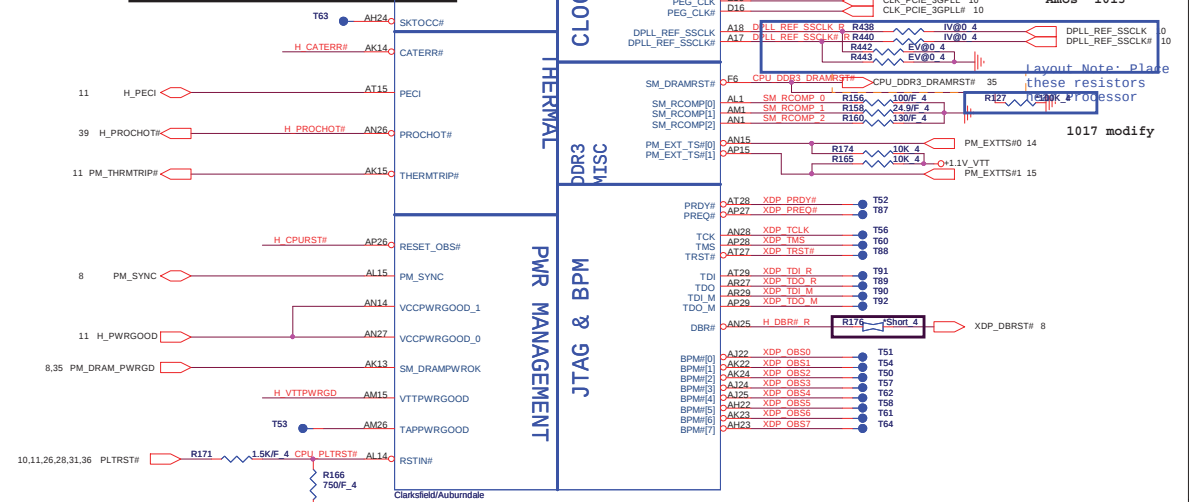
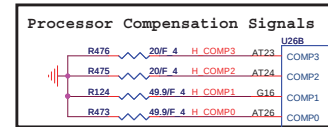
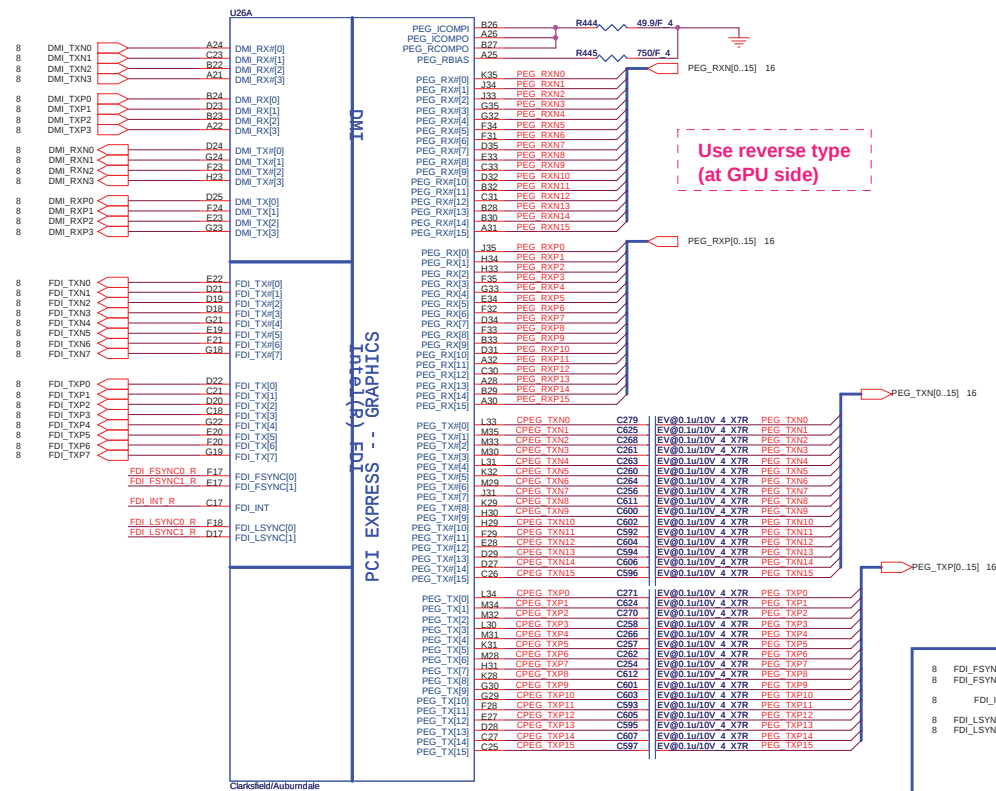


CLK Enable

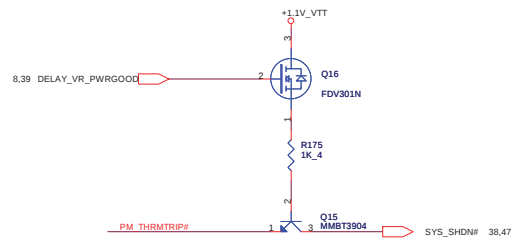


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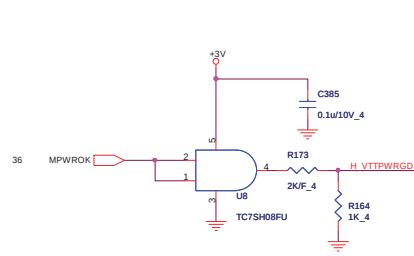
Size	Document Number	Rev
	Clock Generator	3B
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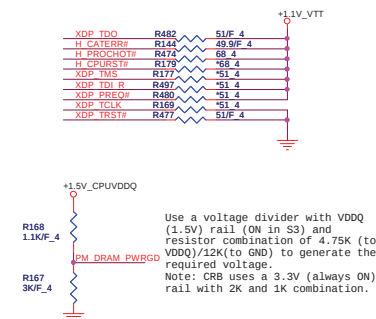
Thermaltrip protect



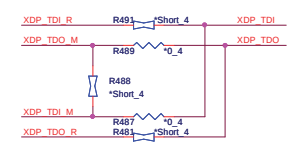
VTT PWR_Good



Processor pull-up

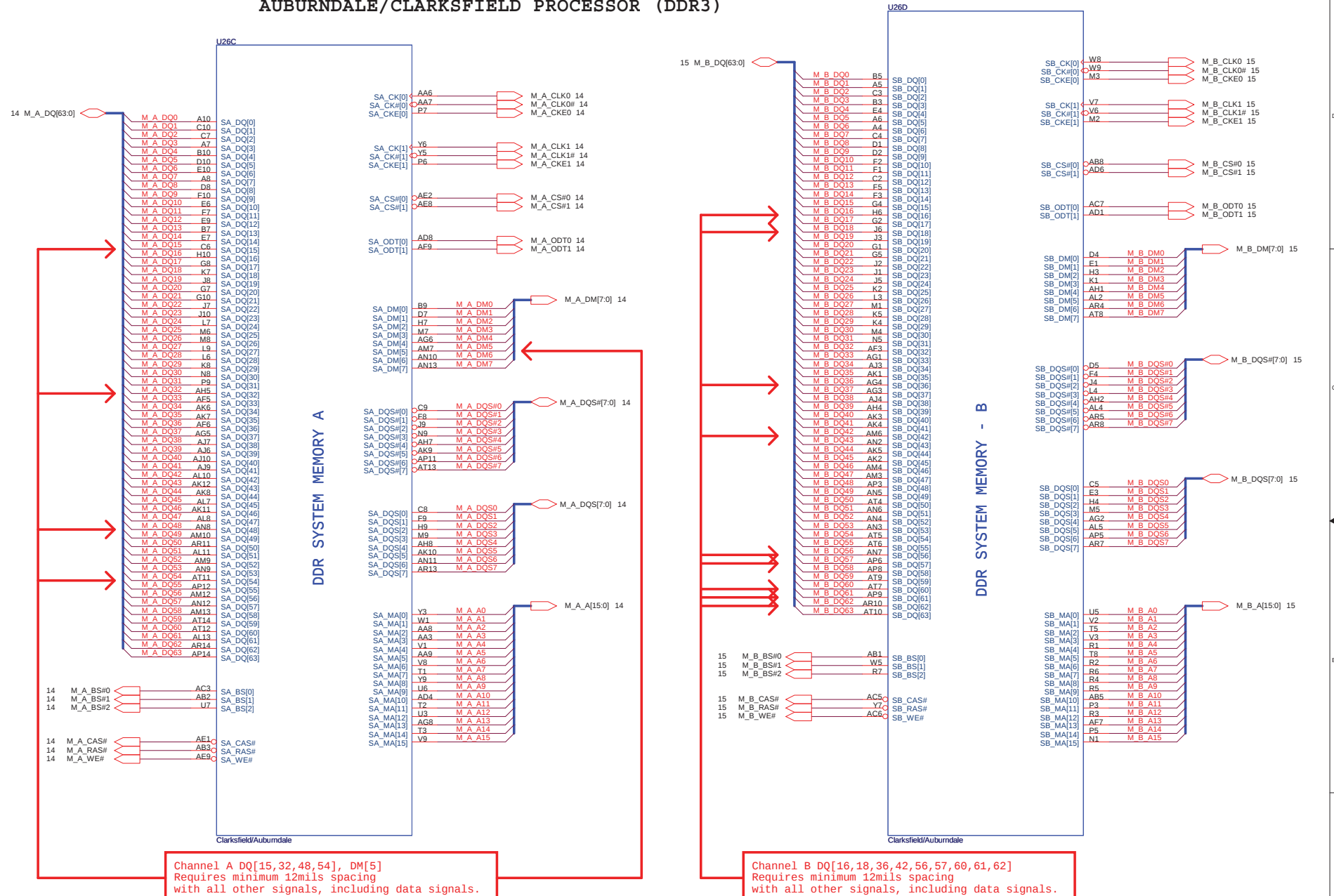


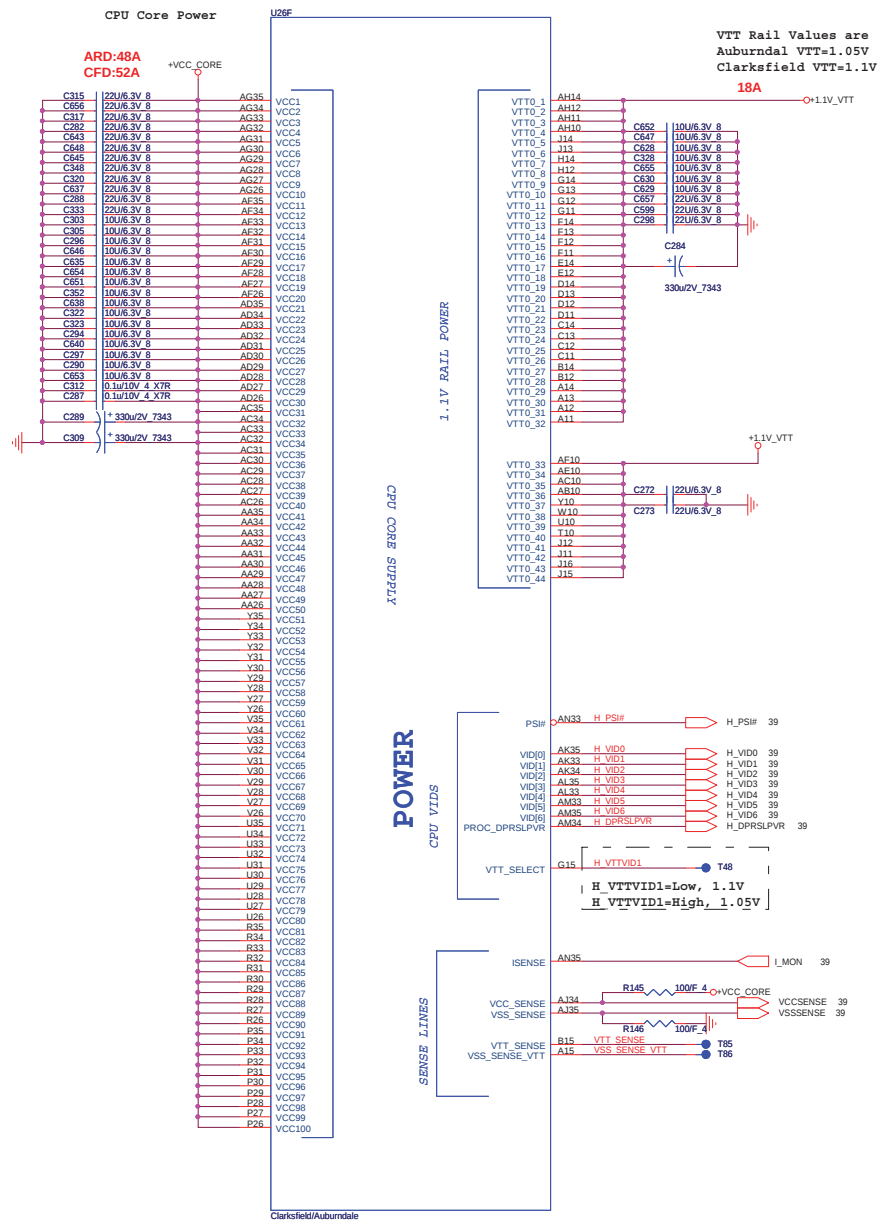
JTAG MAPPING



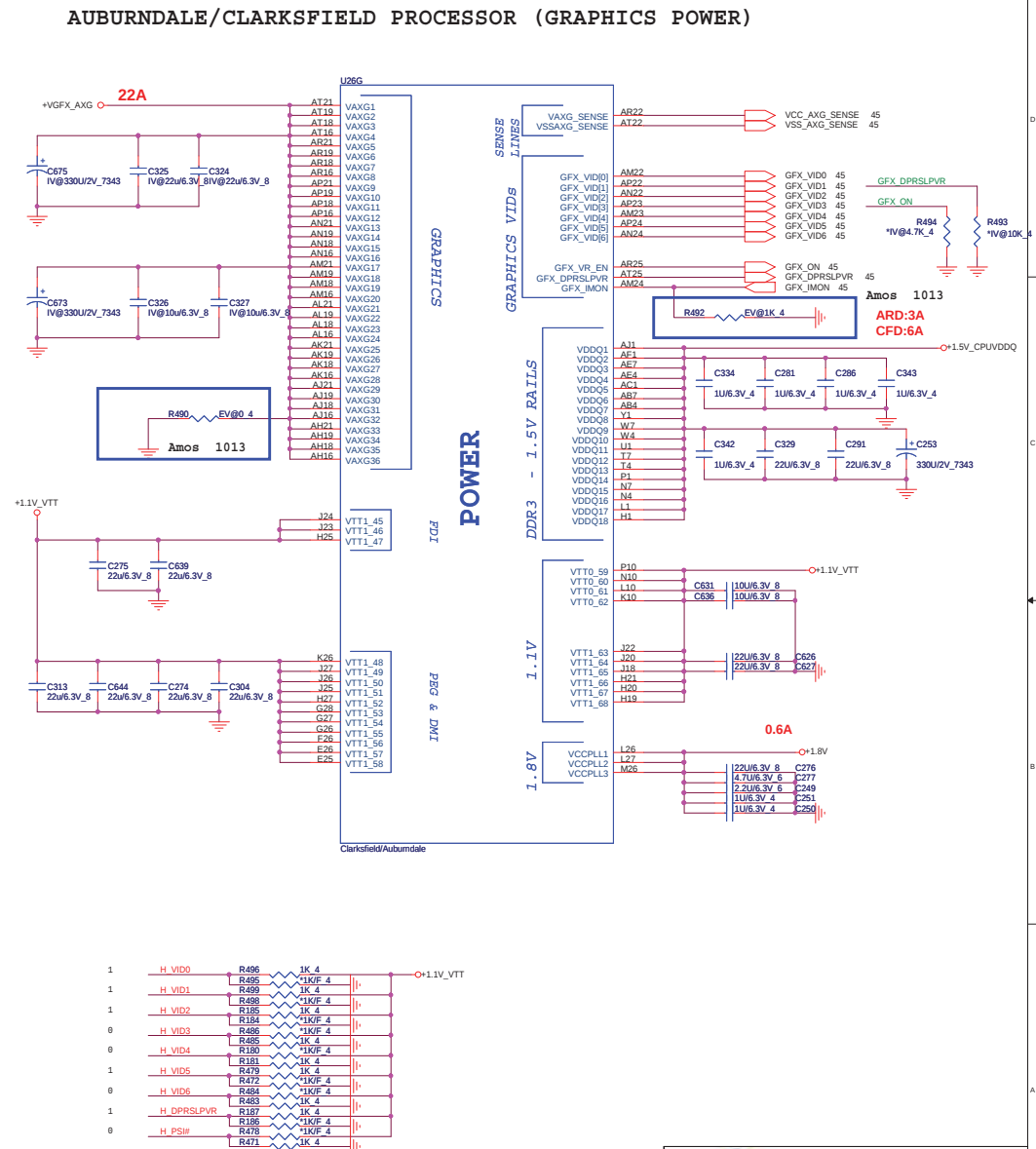
Scan Chain (Default)	STUFF -> R469, R491, R507 NO STUFF -> R489, R490
CPU Only	STUFF -> R490, R491 NO STUFF -> R469, R489, R507
GMCH Only	STUFF -> R489, R507 NO STUFF -> R491, R490, R469

AUBURNDALE/CLARKSFIELD PROCESSOR (DDR3)





AUBURNDALE/CLARKSFIELD PROCESSOR (POWER)



Note:
For Validating IMVP VR R6451 should be STUFF
and R2N1 NO_STUFF

```
HFM_VID : Max 1.4V
LFM_VID : Min 0.65V
```

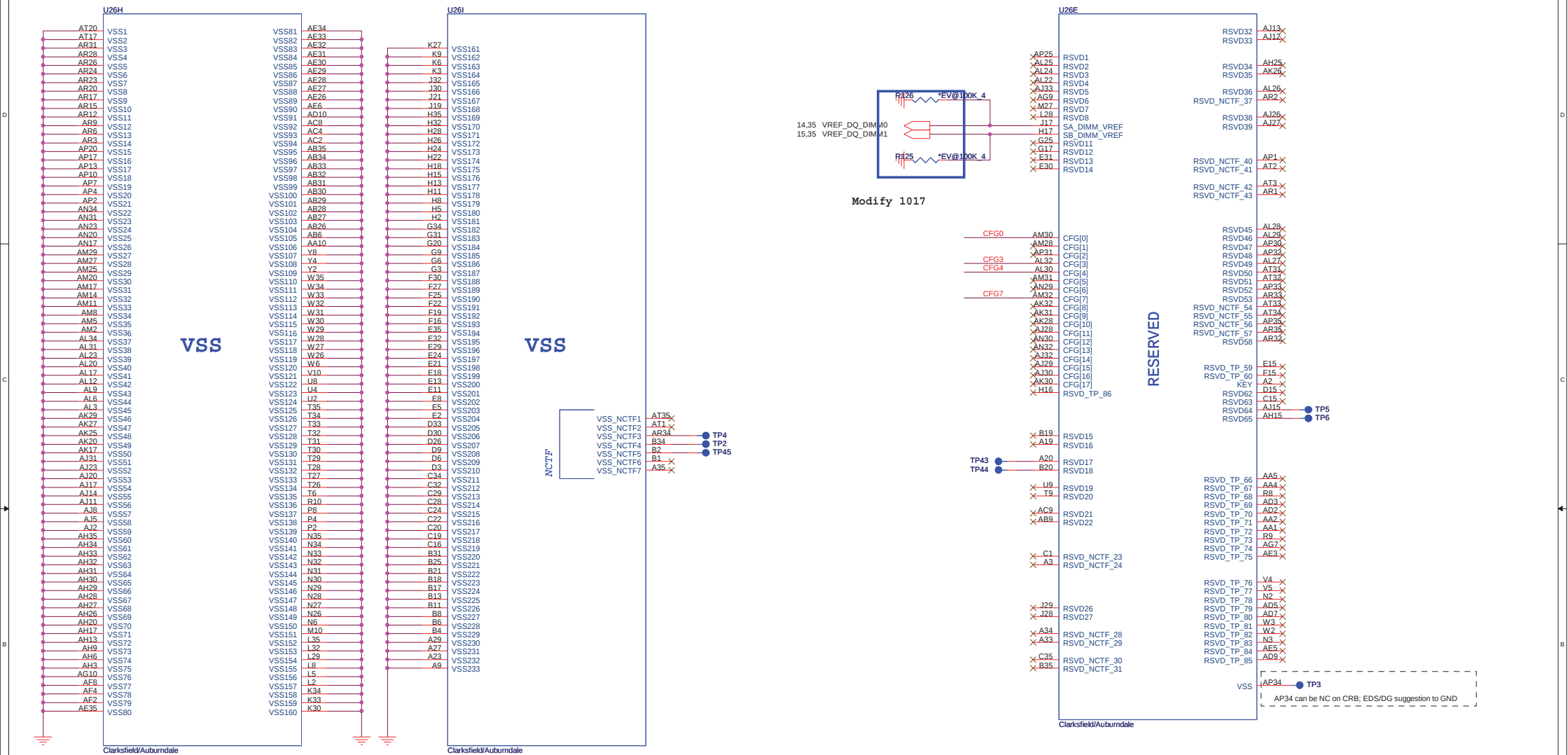


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Size	Document Number	Rev
	AUBURNDA 3/4 (PWR)	3B
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AUBURNDALE/CLARKSFIELD PROCESSOR (GND)

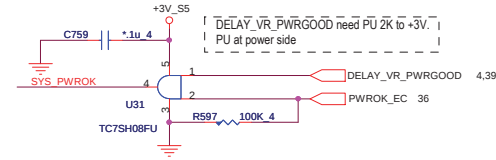
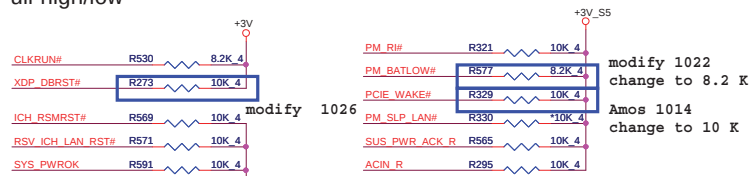
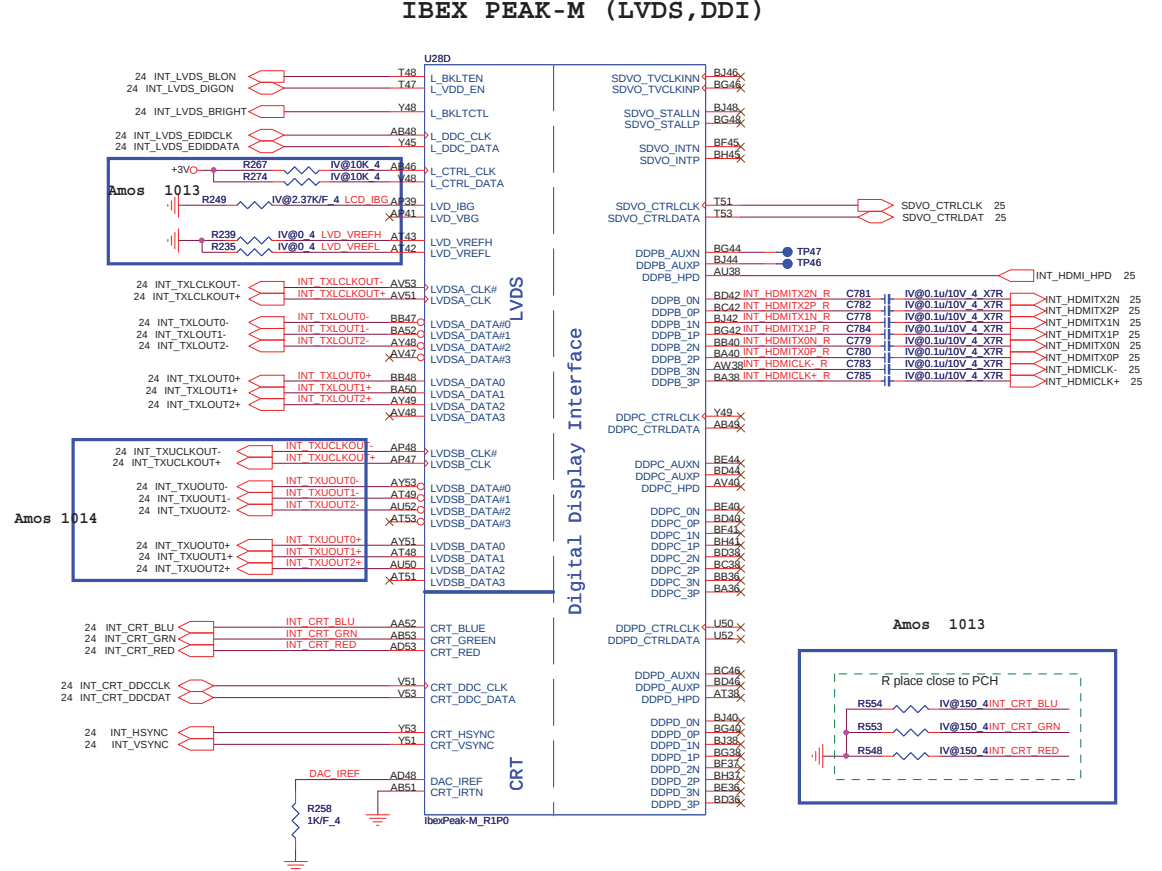
AUBURNDALE/CLARKSFIELD PROCESSOR (RESERVED, CFG)



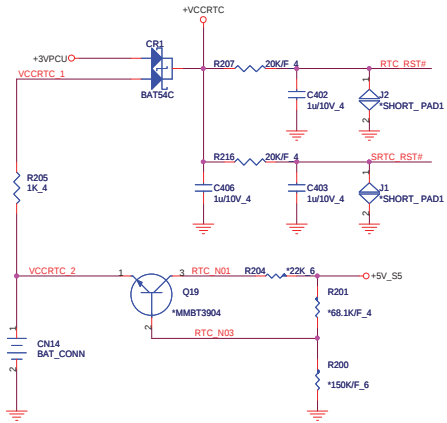
Processor Strapping

	1	0	DEFAULT	
CFG0 (PCI-Epress Configuration Select)	Single PEG	Bifurcation enabled	1	CFG0 R172 *3.01K NC
CFG3 (PCI-Epress Static Lane Reversal)	Normal Operation	Lane Numbers Reversed	1	CFG3 R159 *3.01K/F 4
CFG4 (Embedded Display Port Presence)	Disabled; No Physical Display Port attached to Embedded Display Port	Enabled; An external Display port device is connected to the Embedded Display port	1	CFG4 R157 *3.01K
TP3				CFG7 R161 *3.01K/F 4

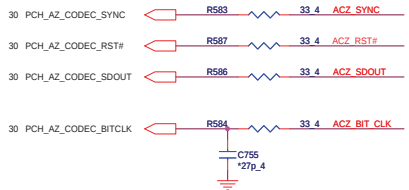
IBEX PEAK-M (LVDS, DDI)



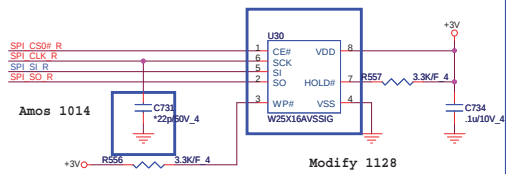
RTC Circuitry



HDA Bus

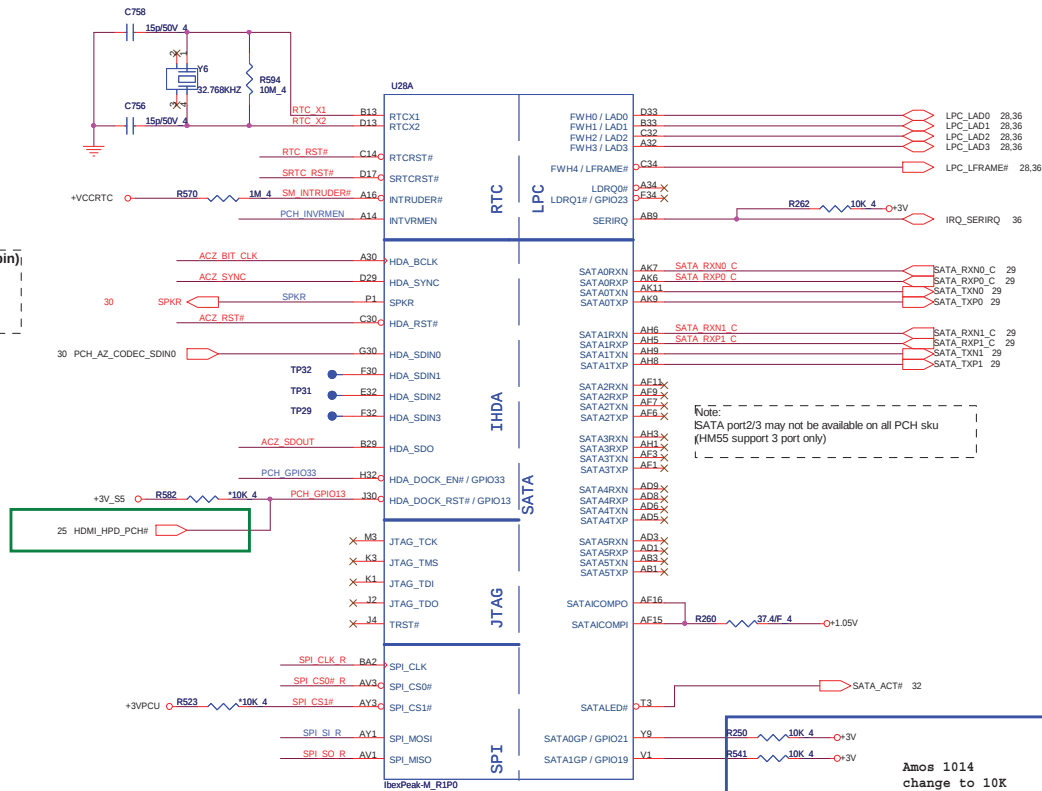


MDC Bus



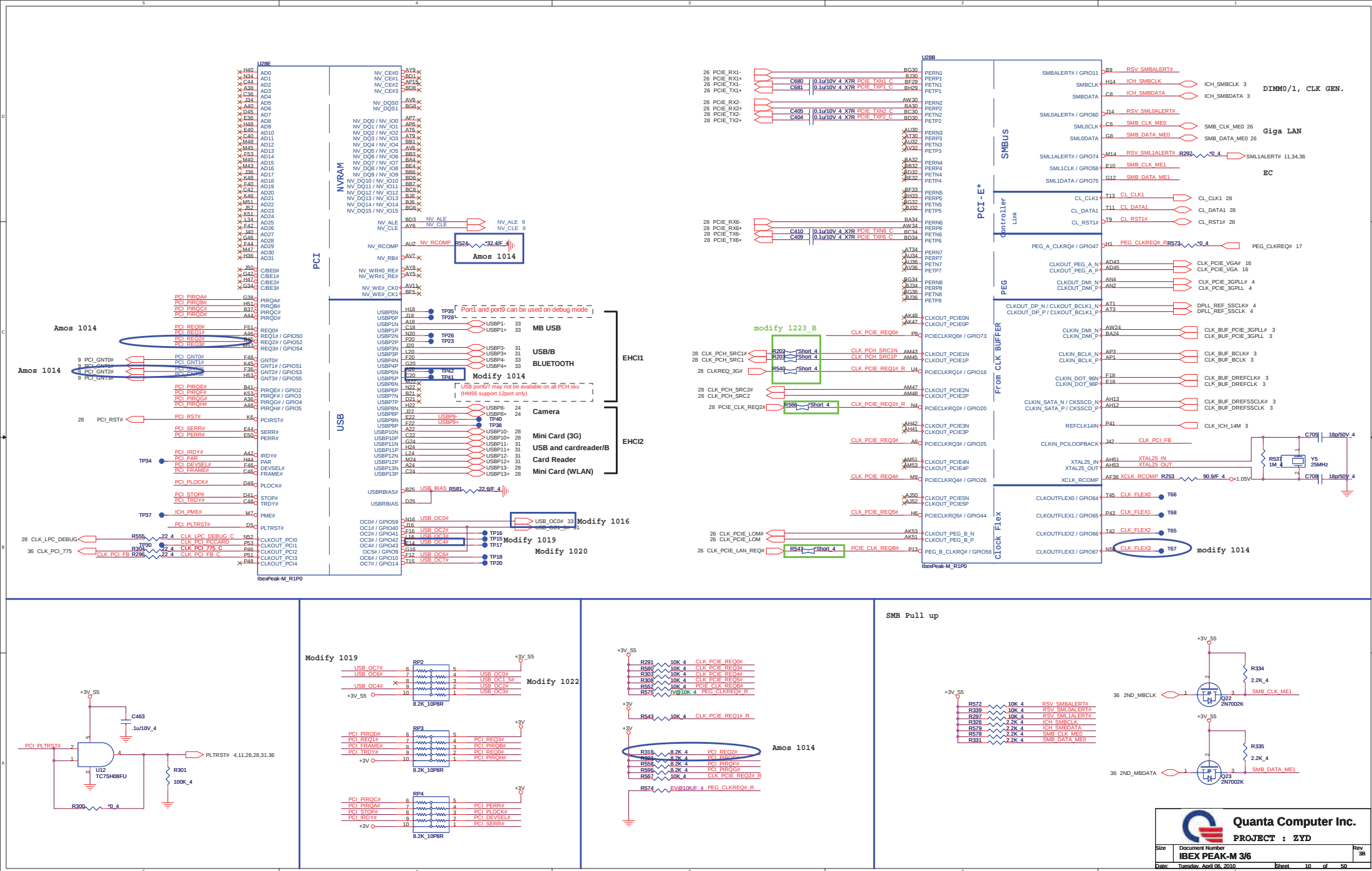
PCH SPI

HDA_SYNC (PCH strap pin)
Internal weak pull-down
VCCVRM=>+1.8V (default)
external pull-up
VCCVRM=>+1.5V

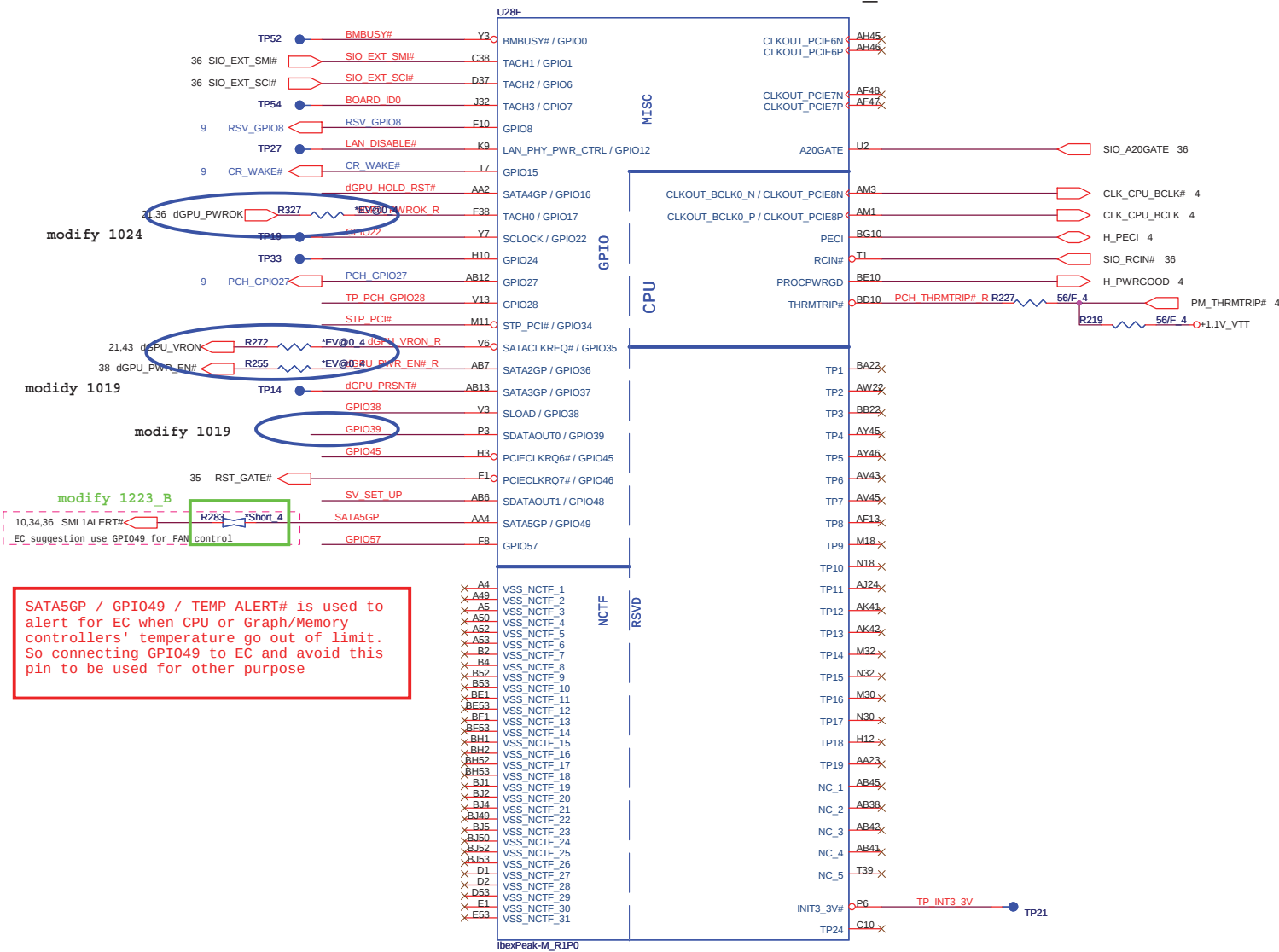


PCH Strap Pin Configuration Table-1

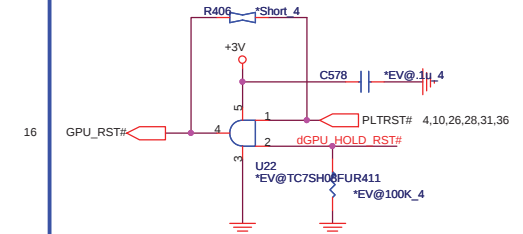
INTVRMEN	Integrated 1.05V VRM Enable / Disable	1 = Integrated VRM is enabled 0 = Integrated VRM is disabled	+VCCRTC R593 330K 6 PCH_INVRMEN
SPI_MOSI	TPM Functionality Disable	1 = Enabled 0 = Disable	+3V R559 1K 4 SPI_SI_R
SPKR	Reboot option at power-up	0 = Default Mode (Internal weak Pull-down) 1 = No Reboot Mode with TCO Disabled	+3V R307 1KIF_4 SPKR
HDA_DOCK_EN#	Flash Descriptor Security Override	0 = Flash Descriptor Security will be overridden 1 = Security measure defined in the Flash Descriptor will be enabled.	PCH_GPIO33 J3 1 2 R322 10K 4
GNT0#, GNT1#	Boot BIOS Strap	(0,0) = LPC (0,1) = Reserved NAND (1,0) = PCI (1,1) = SPI	10 PCI_GNT0# R315 1K 4 10 PCI_GNT1# R310 1K 4
GNT2#	ES1 Strap (Server Only)	ES1 compatible mode is for server platforms only	10 PCI_GNT2# R313 1KIF_4
GNT3#	Top-Block Swap Override	0 = Top Block Swap Mode 1 = Default Mode (Internal pull-up)	10 PCI_GNT3# R560 10KIF_4
NV_ALE	IntelR Anti-Theft Technology HDD Data Protection (Intel AT-d) Enable	1 = Enabled 0 = Disabled (Default)	10 NV_ALE R231 1KIF_4 +1.8V
NV_CLE	DMI Termination Voltage	DMI termination voltage. Weak internal pull-up. Do not pull low.	10 NV_CLE R230 1KIF_4 +1.8V
GPI08	Reserved	This signal has a weak internal pull up. NOTE: This signal should not be pulled low	11 3V_GPI08 R325 10K 4 +3V_SS R320 1K 4
GPI015	Reserved	0 = Intel ME Crypto Transport Layer Security (TLS) cipher suite with no confidentiality 1 = Intel ME Crypto Transport Layer Security (TLS) cipher suite with confidentiality	CR_WAKE# R282 1K 4 +3V_SS
GPI027	On-Die PLL Voltage Regulator <internal weak pull-up>	0 = Disables the VccVRM. 1 = Enables the internal VccVRM to have a clean supply for analog rails.	11 PCH_GPIO27 R263 10K 4



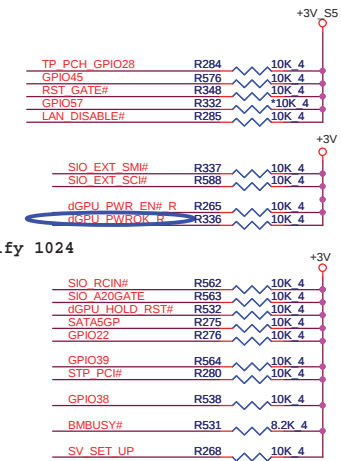
IBEX PEAK-M (GPIO, VSS_NCTF, RSVD)



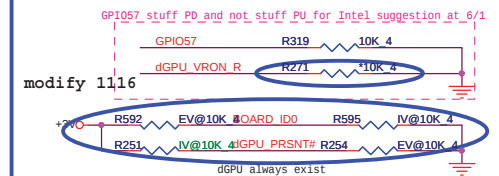
GPU RST#



GPIO Pull-up/Pull-down

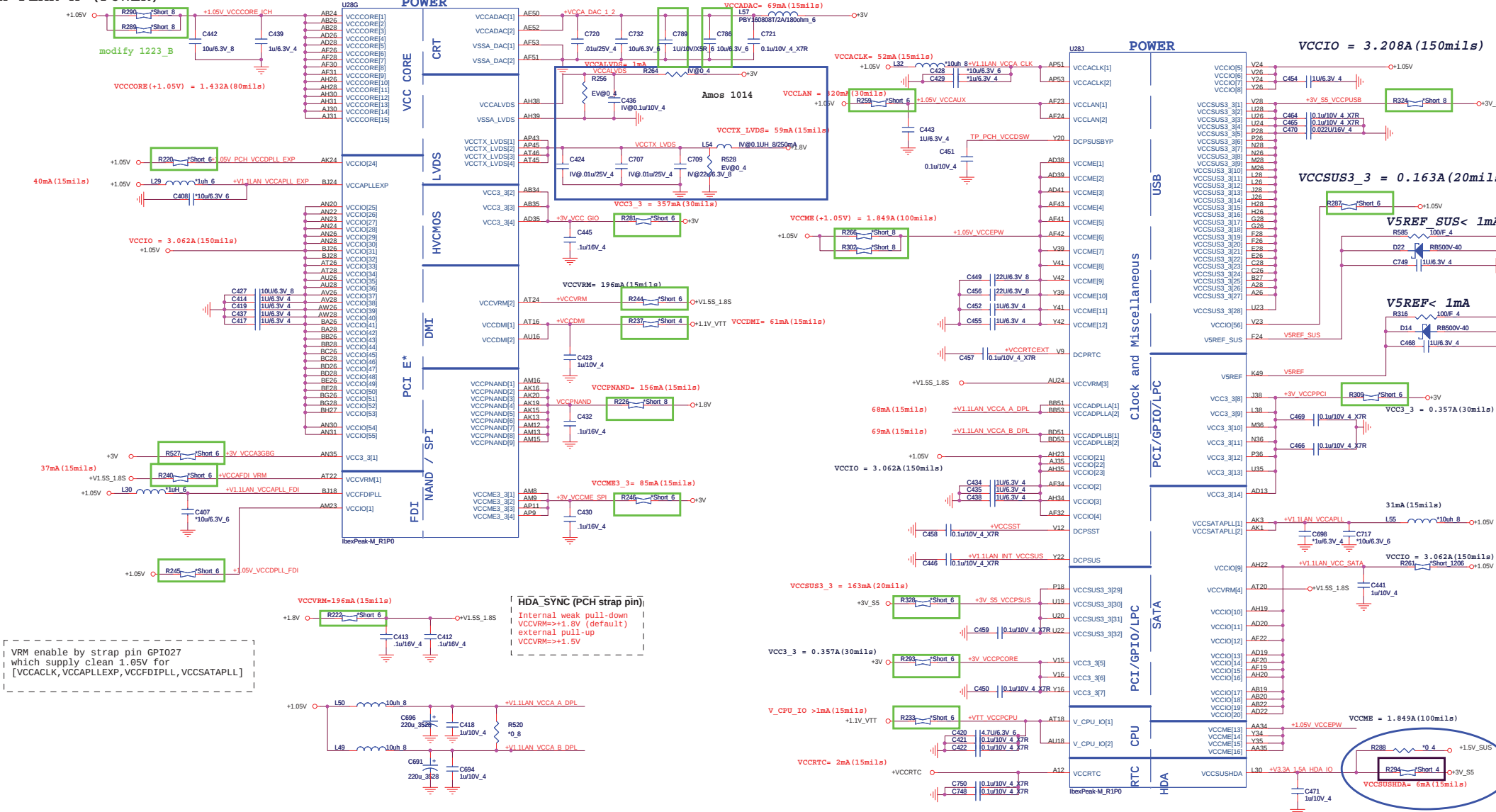


SV_SET_UP	1-X High = Strong (Default)
-----------	-----------------------------

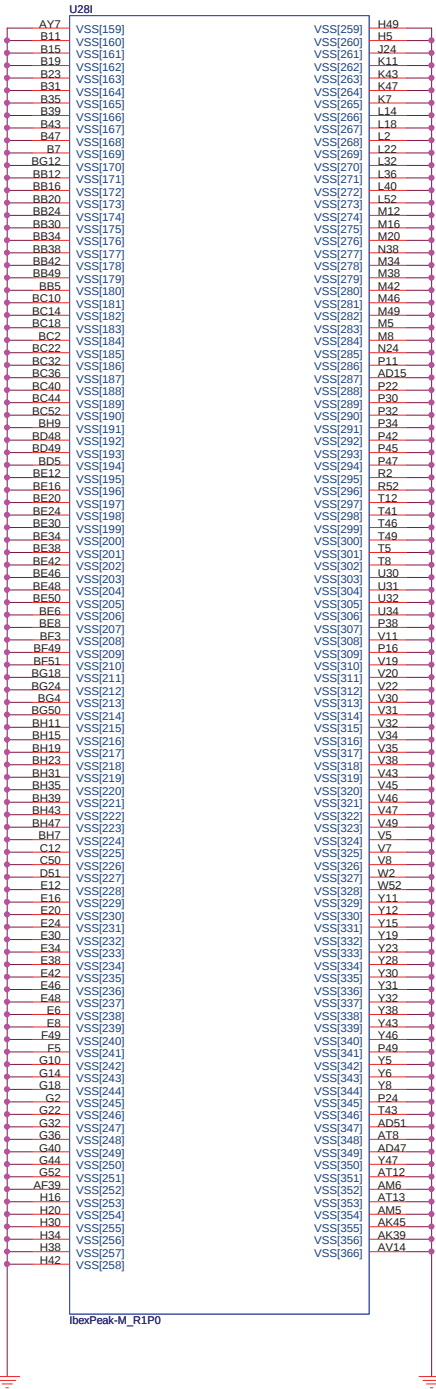
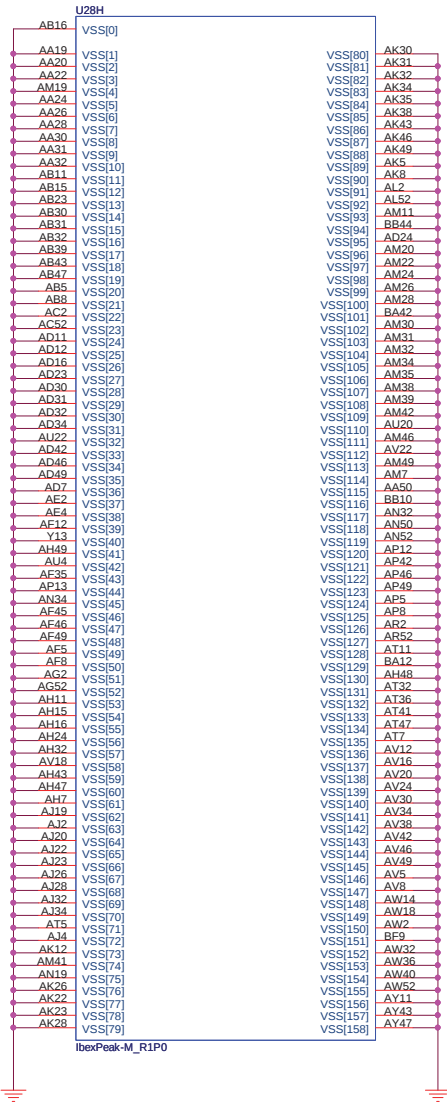


Integrated Clock Chip Enable	
BOARD_ID0	High = Discrete Low = IV
RSV_GPIO8	High = Disable Low = Enable

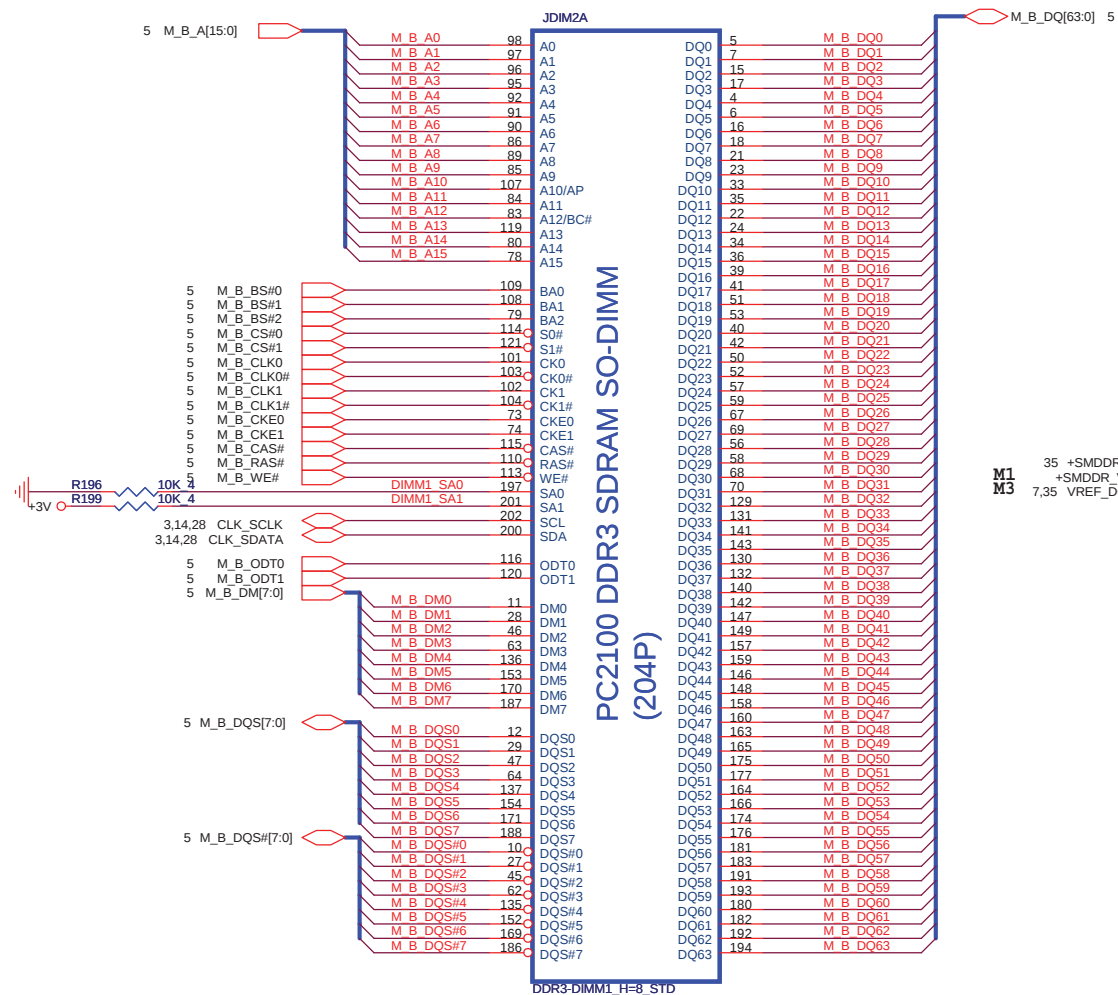
IBEX PEAK-M (POWER)



IBEX PEAK-M (GND)



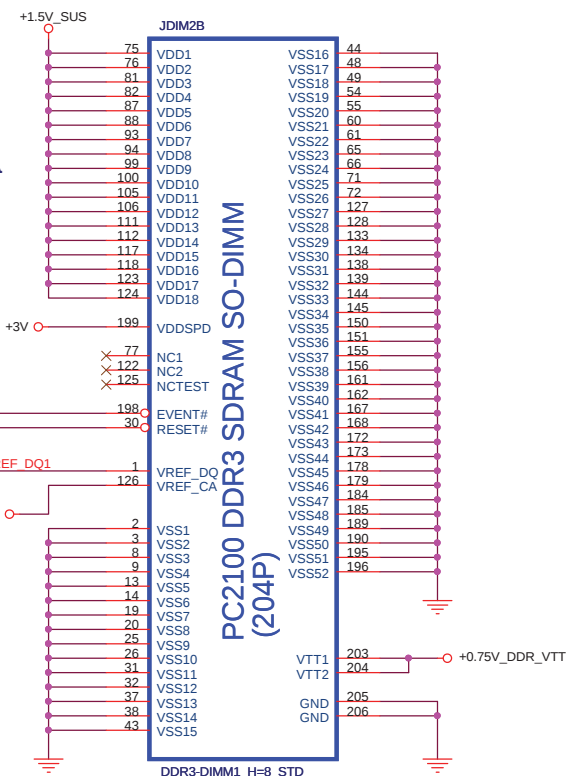
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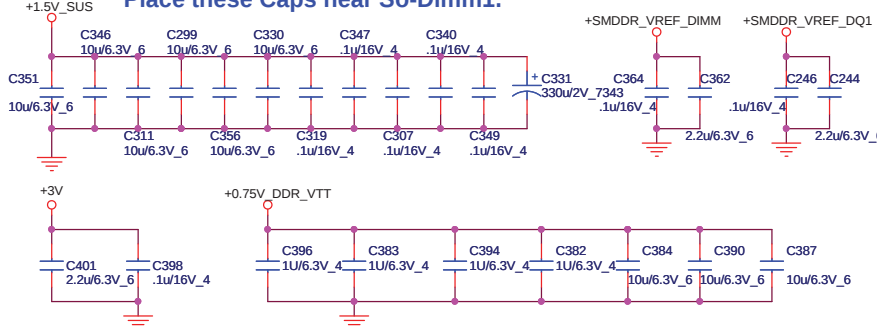
2.48A

M1
M3

Modify 1017



Place these Caps near So-Dimm1.

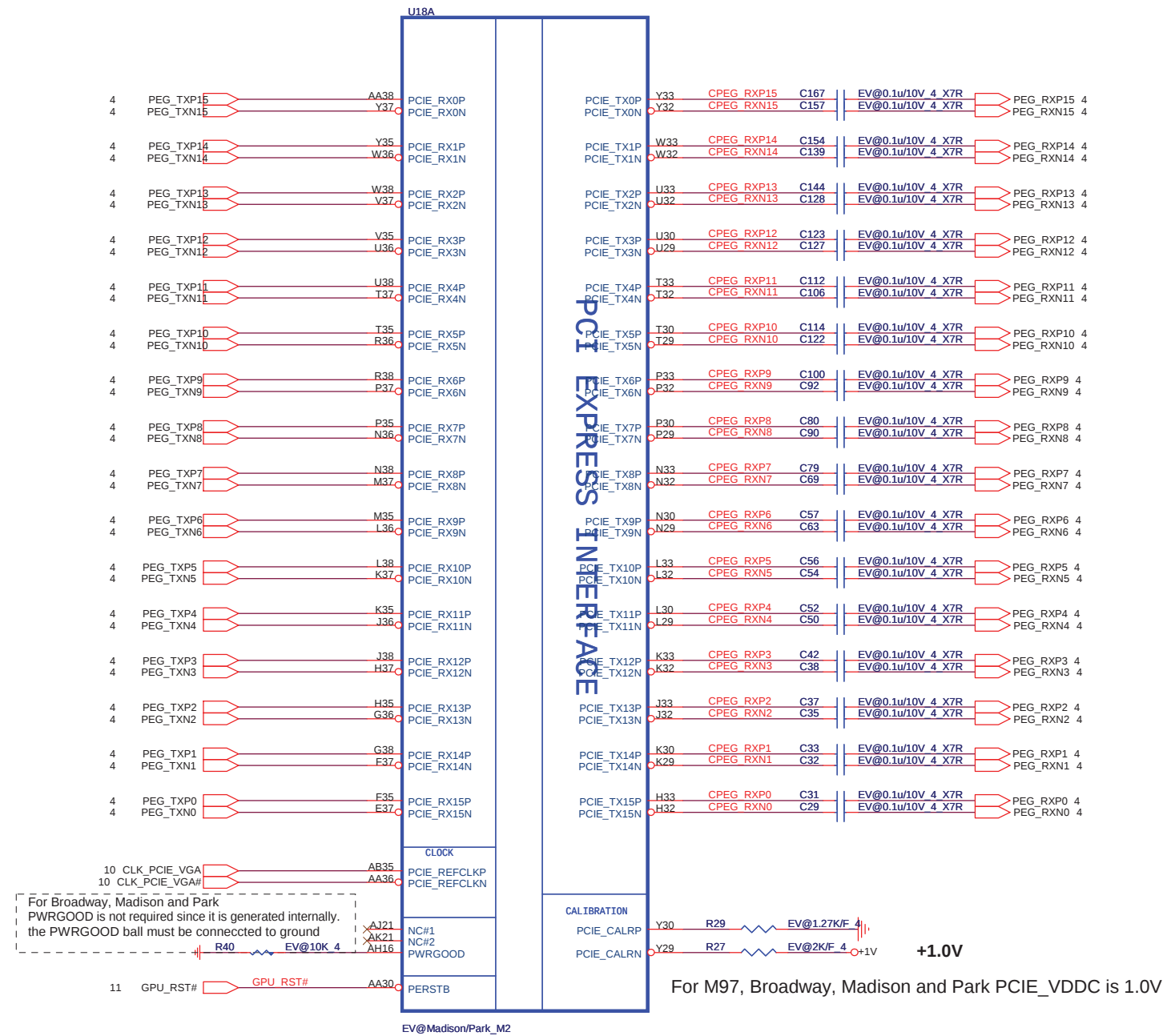


For Arrandale only designs--->Only method M1 should be enabled.
For Clarksfield only designs--->Both M1 AND M3 methods should be enabled simultaneously
For Common Motherboard designs--->Both M1 AND M3 methods should be enabled simultaneously.

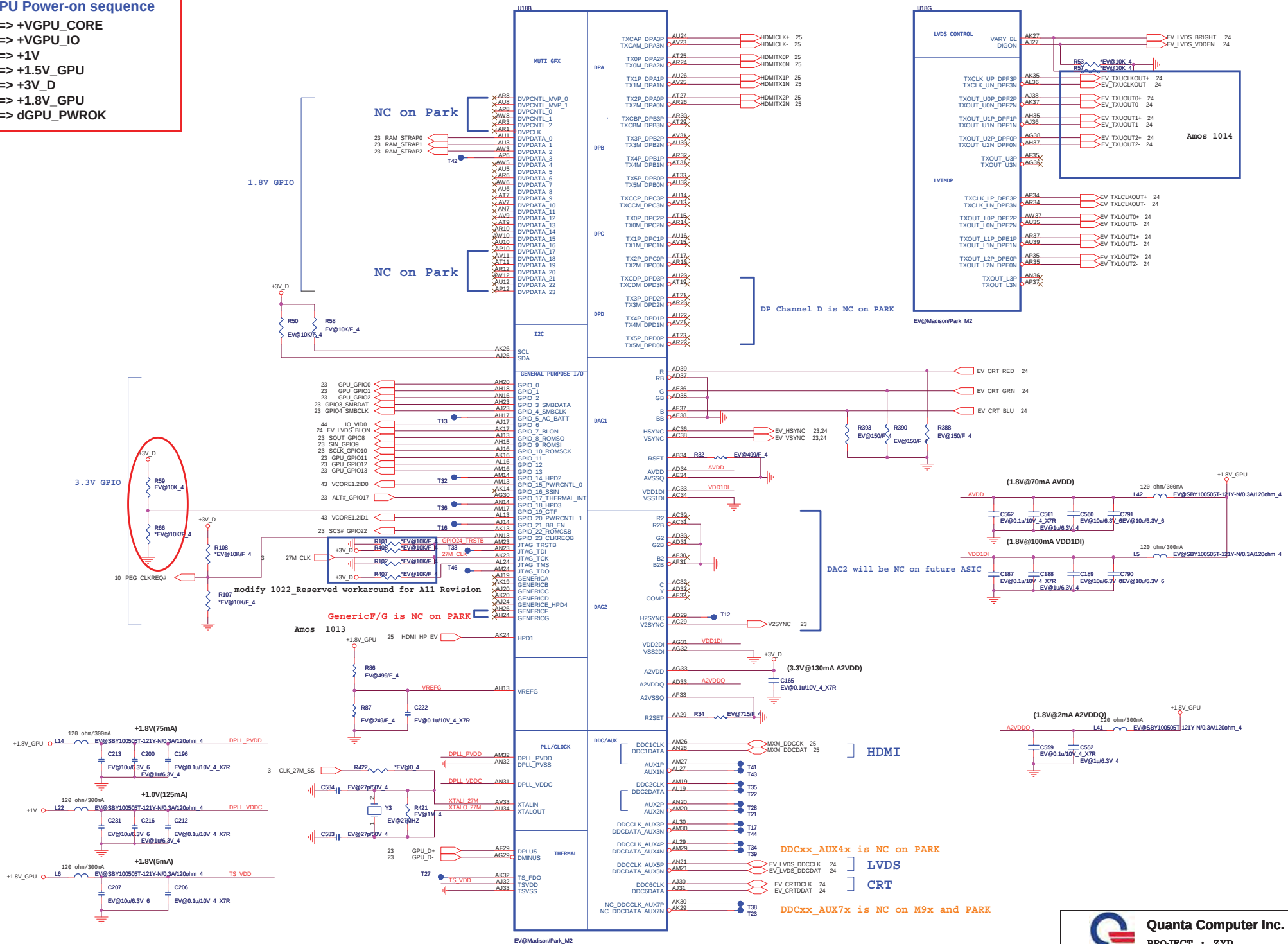


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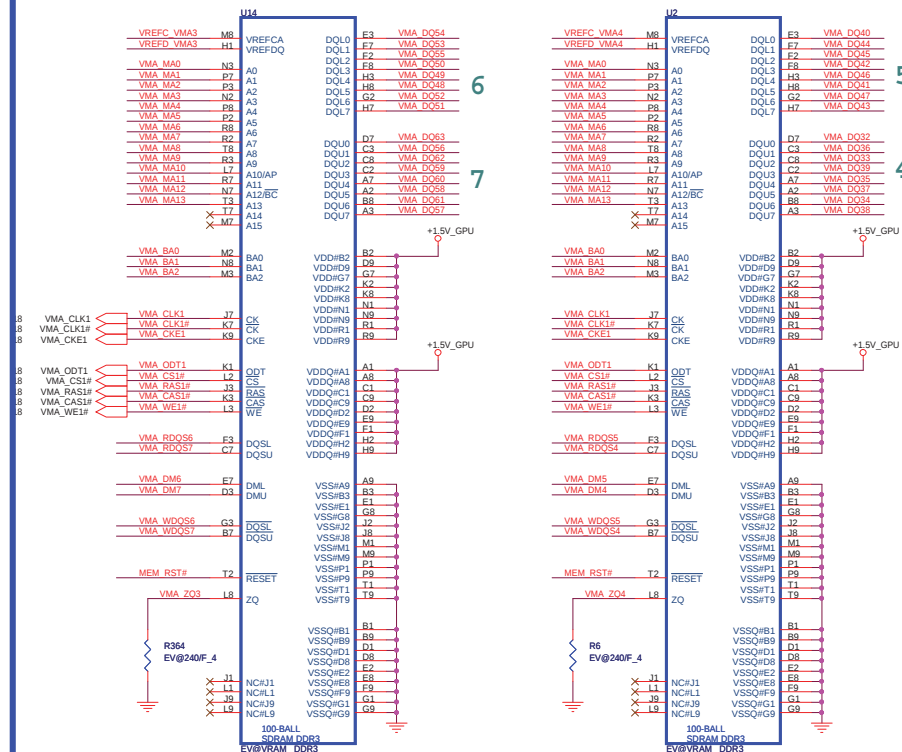
Size	Document Number	Rev
	DDRIII SO-DIMM-1	3B
Date:	Tuesday, April 06, 2010	Sheet 15 of 50



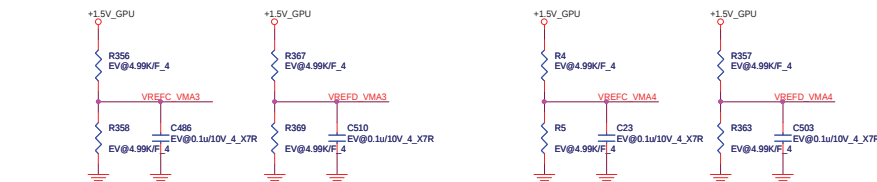
```
1 => +VGPU_CORE
2 => +VGPU_IO
3 => +1V
4 => +1.5V_GPU
5 => +3V_D
6 => +1.8V_GPU
7 => dGPU_PWROK
```



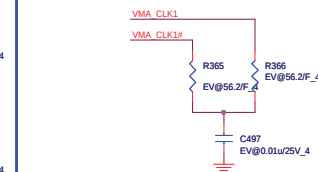
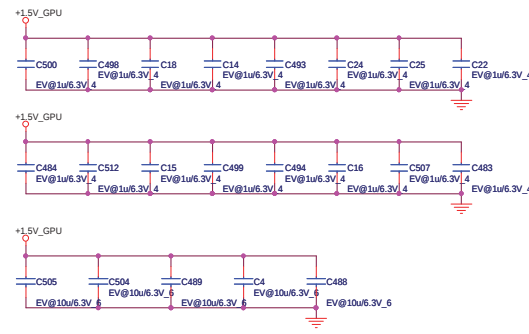
Park, M92M Use Channel B Memory Interface Only



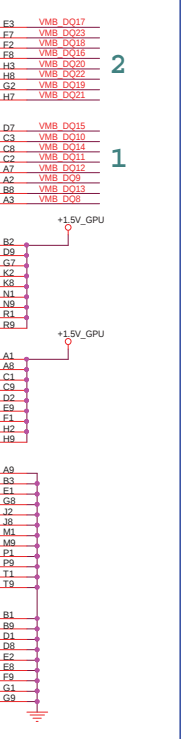
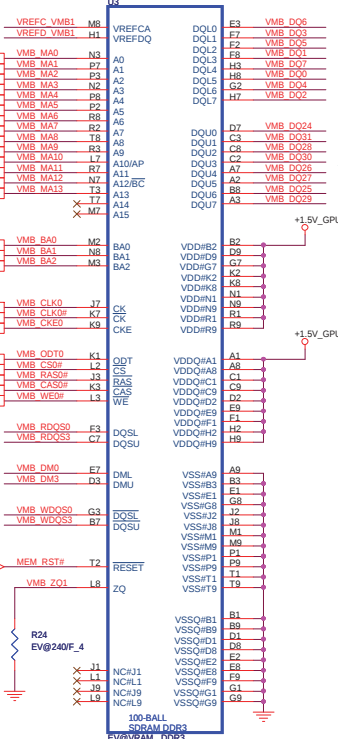
TOP Right



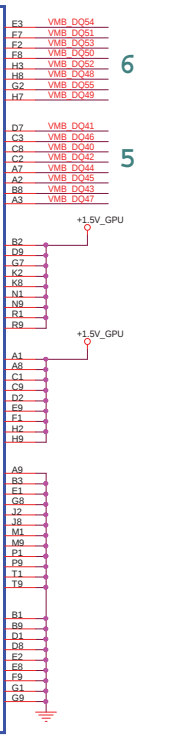
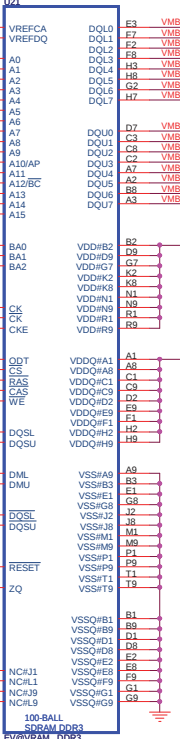
MEM A1 CLK



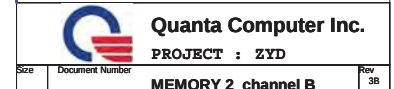
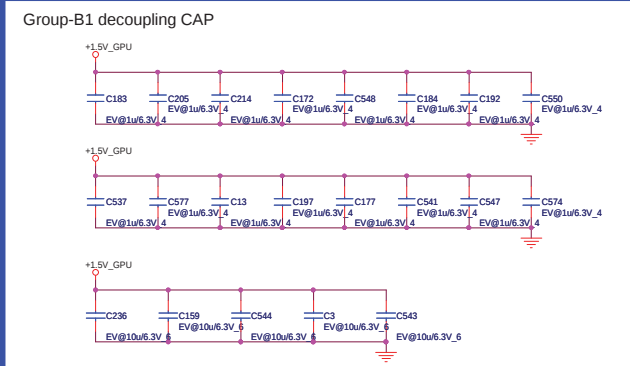
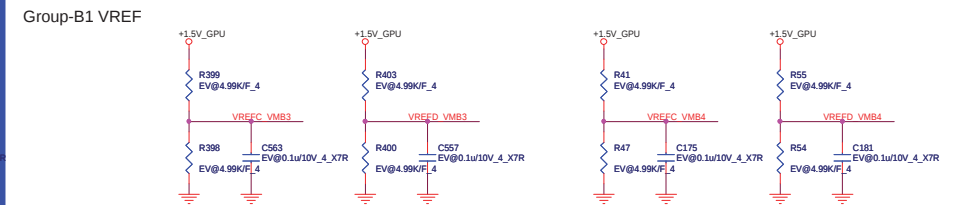
18	VMB_DQ[63..0]		<u>VMB_DQ[63..0]</u>
18	VMB_DM[7..0]		<u>VMB_DM[7..0]</u>
8	VMB_RDQS[7..0]		<u>VMB_RDQS[7..0]</u>
8	VMB_WDQS[7..0]		<u>VMB_WDQS[7..0]</u>

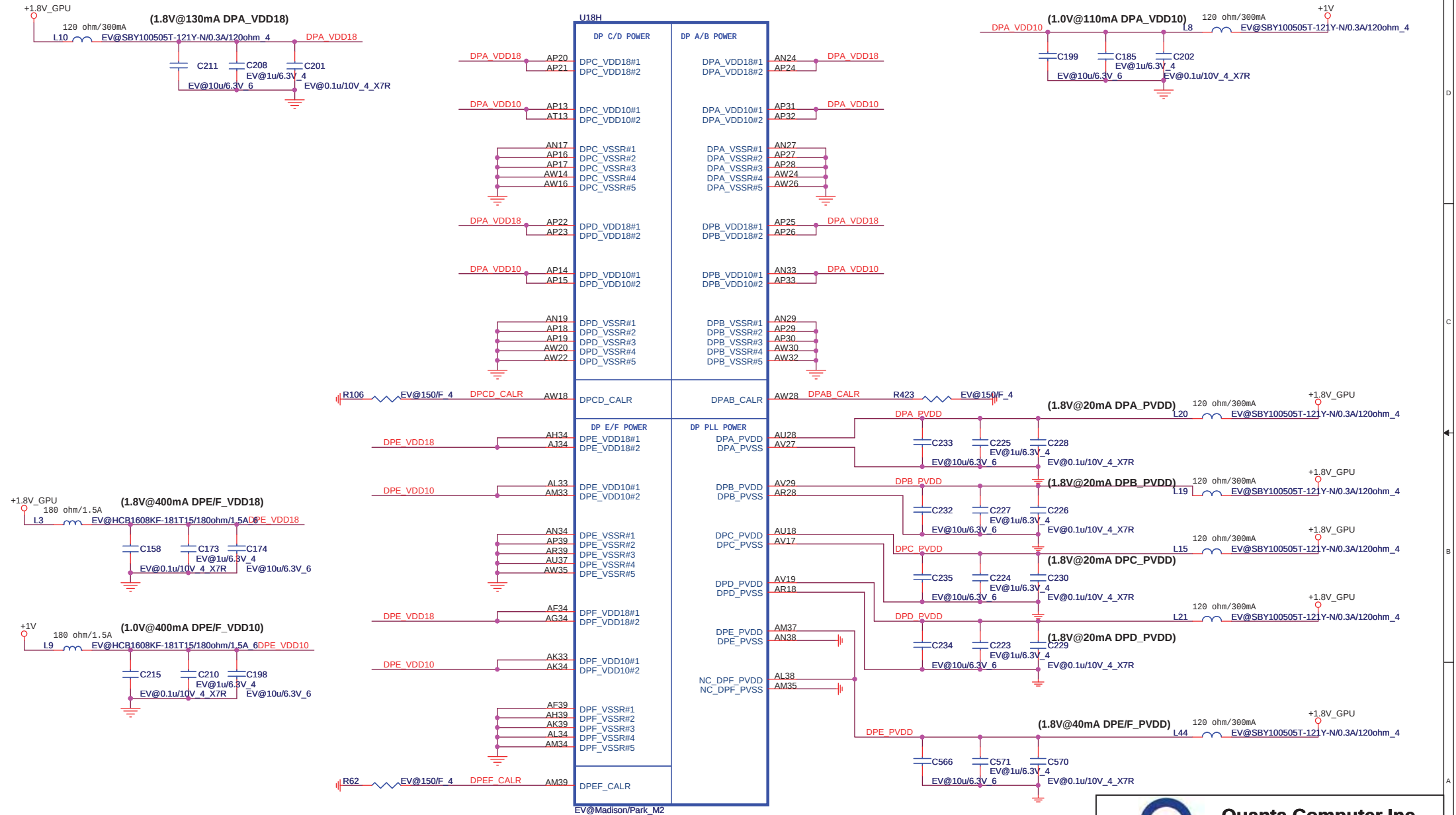


100

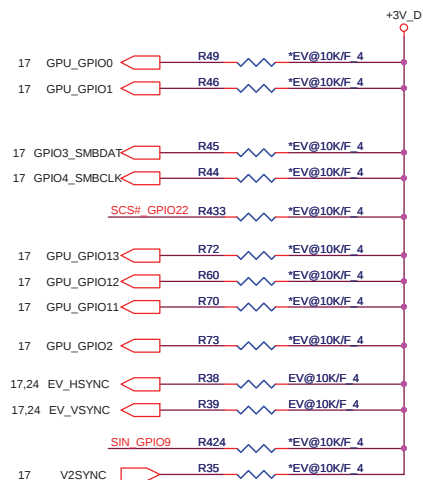


11





PIN STRAPS



Memory Aperture size

GPIO[13:11]	Size
000	128MB
001	256MB
010	64MB
011	32MB

Audio Table

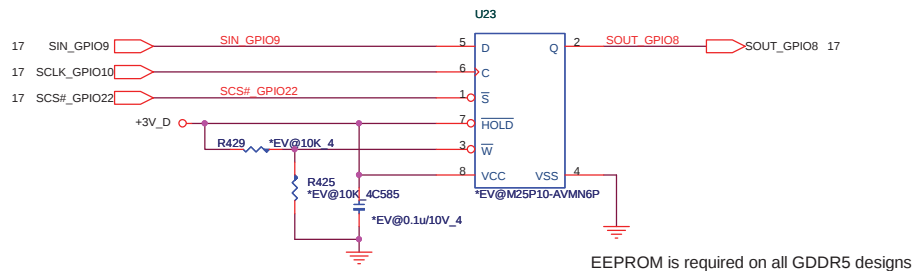
EXT_HSYNC	EXT_VSYNC	Discription
0	0	No Audio
0	1	Any one by dectec
1	0	DP only
1	1	Both DP & HDMI

CONFIGURATION STRAPS

ALLOW FOR PULLUP PADS FOR THESE STRAPS AND IF THESE GPIOs ARE USED, THEY MUST NOT CONFLICT DURING RESET

STRAPS	PIN	DESCRIPTION OF DEFAULT SETTINGS	DEFAULT	REMARK
TX_PWRS_ENB	GPIO0	0 = 50% TX OUTPUT SWING 1 = FULL TX OUTPUT SWING	0	
TX_DEEMPH_EN	GPIO1	PCIE TRANSMITTER DE-EMPHASIS ENABLED 0 = TX DE-EMPHASIS DISABLED 1 = TX DE-EMPHASIS ENABLED	0	
BIOS_ROM_EN	GPIO_22_ROMCSB	ENABLE EXTERNAL BIOS ROM 0 = DISABLE 1 = ENABLE	0	
ROMIDCFG(2:0)	GPIO[13:11]	SERIAL ROM TYPE OR MEMORY APERTURE SIZE SELECT	000	See Memory Aperture size
BIF_GEN2_EN_A	GPIO2	0 = PCIE DEVICE AS 2.5GT/S CAPABLE 1 = PCIE DEVICE AS 5GT/S CAPABLE	0	
GPIO_8_ROMSO H2SYNC GPIO_21_BB_EN	GPIO8 H2SYNC GPIO21	Reserved Only	0	
AUD[1] AUD[0]	HSYNC VSYNC	AUD[1:0] 00: NO AUDIO FUNCTION. 01: AUDIO FOR DISPLAYPORT AND HDMI IF ADAPTER IS DETECTED. 10: AUDIO FOR DISPLAYPORT ONLY. 11: AUDIO FOR BOTH DISPLAYPORT AND HDMI.	11	See Audio table
GPIO_9_ROMSI	GPIO9	0 = VGA controller capacity enable	0	
VIP_DEVICE_STRAP_ENA	V2SYNC	0 = DRIVER would ignore the value sample on VHAD_0 during RESET.	0	

EEPROM

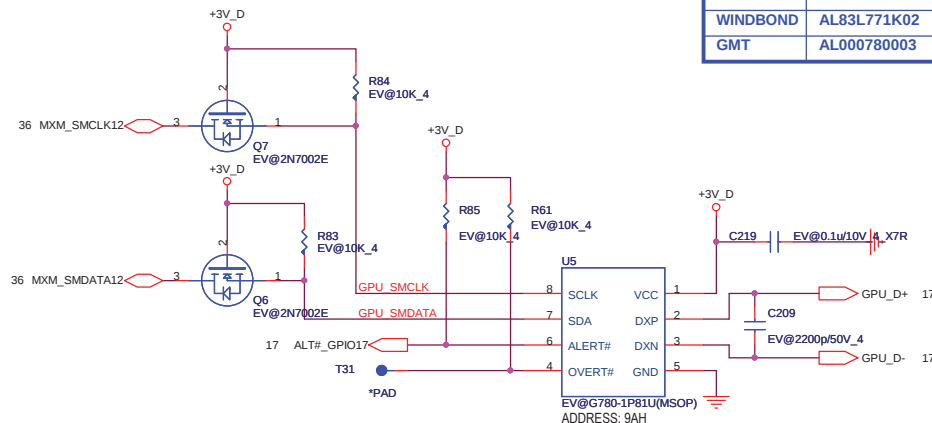


DDR3 Memory Aperture size

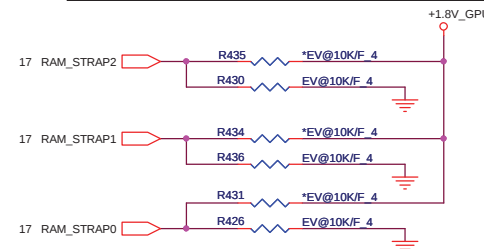
DDR3 VRAM size

Vendor	Vendor P/N	STN B/S P/N	Size	RAM_STRAP2 DVPDATA_2	RAM_STRAP1 DVPDATA_1	RAM_STRAP0 DVPDATA_0
Hynix	H5TQ1G63BFR-12C	AKD5LZGTW04 (64M*16)	512MB	1	1	0
			1GB	1	0	0
			2GB	1	0	1
Samsung	K4W1G1646E-HC12	AKD5LGGT506 (64M*16)	512MB	0	1	0
			1GB	0	0	0
	K4W2G1646B-HC12	AKD5MGGT500	2GB	0	0	1
AMD	23EY2387MA-12	AKD5LGGT700		0	1	0

Thermal Sensor

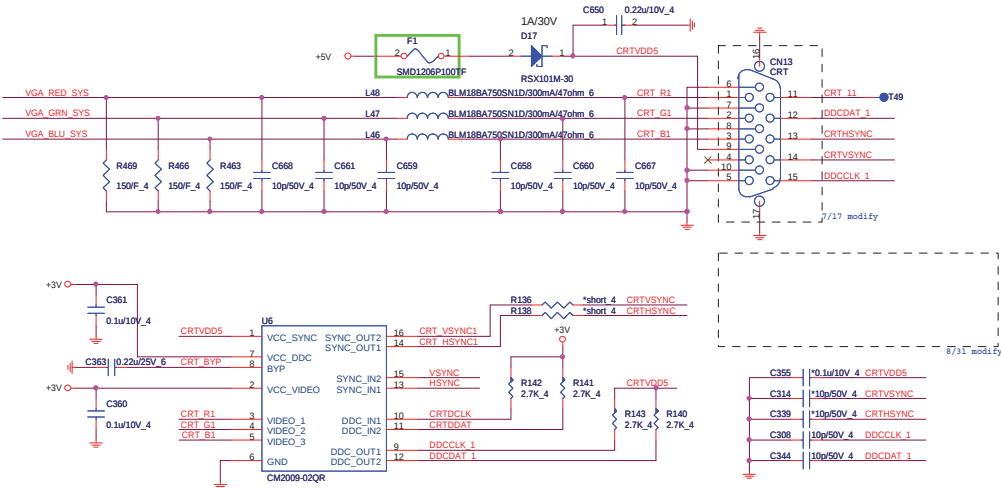
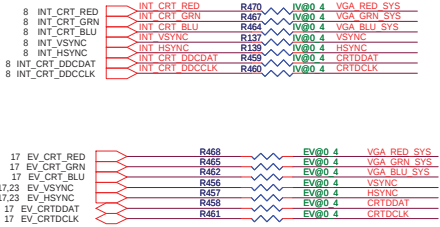
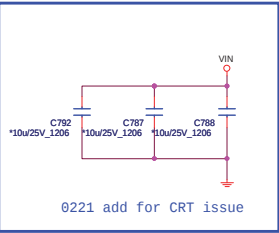


NS	none
WINDBOND	AL83L771K02
GMT	AL000780003

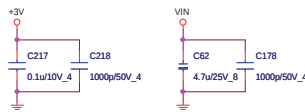
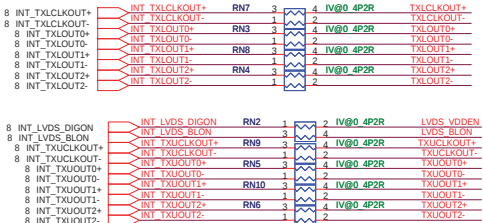
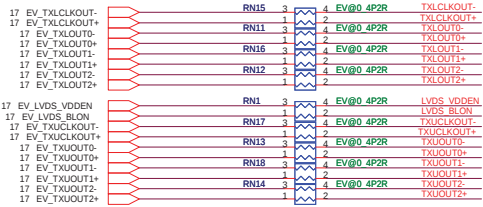
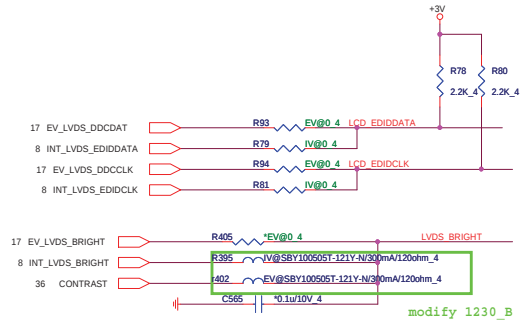


RAM_STRAP2 SET DDR3 Vendor
RAM_STRAP[1:0] SET SIZE.

CRT(CRT)

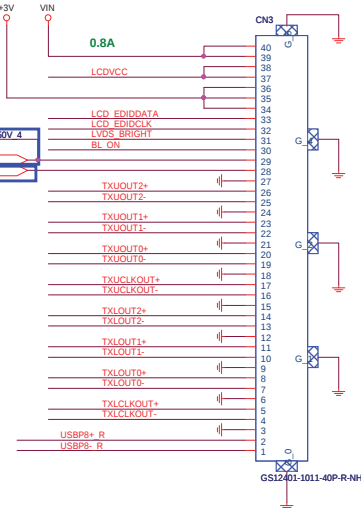


LVDS(LDS)

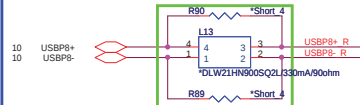


Modify 1021

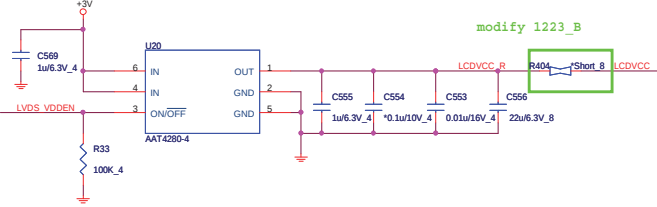
Modify 1102



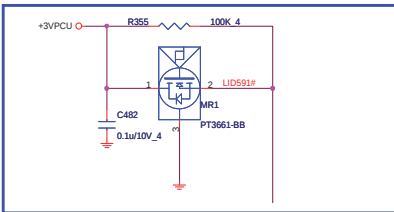
CAMERA Module(CCD)



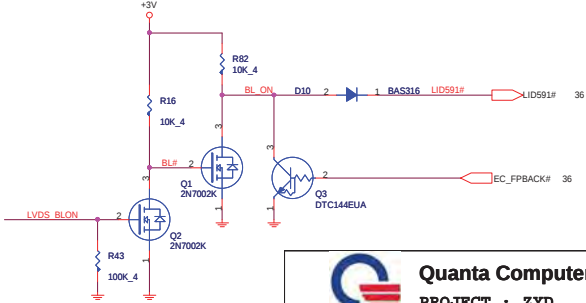
LCD Power(LDS)



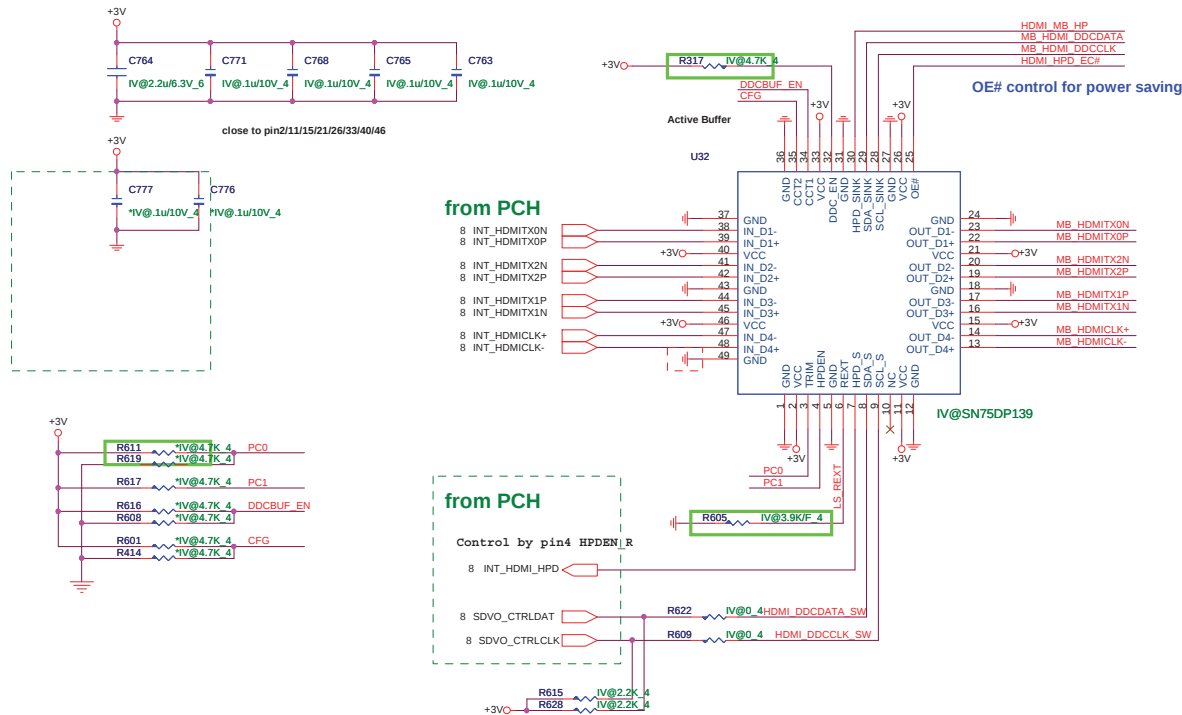
Hall Sensor(HSR)



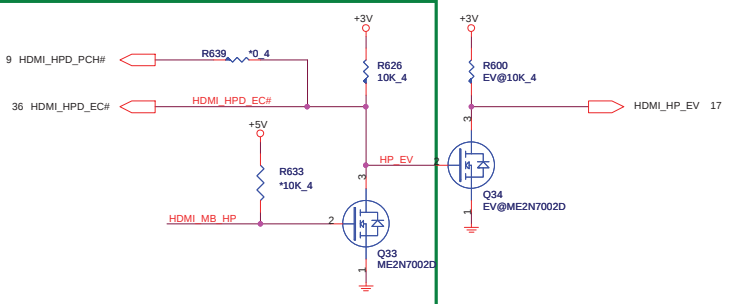
Backlight Control(LDS)



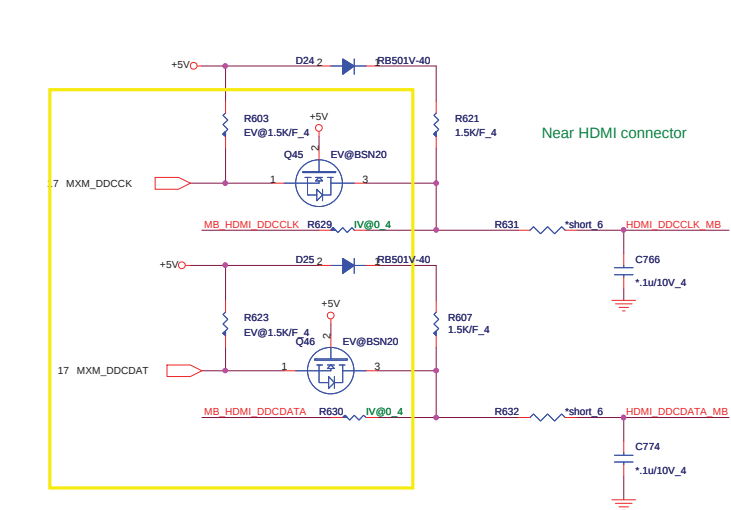
IV@ HDMI LEVEL SHIFTER



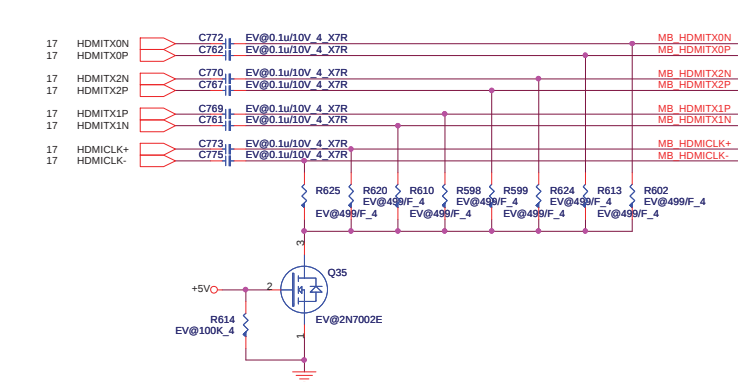
HDMI-detect



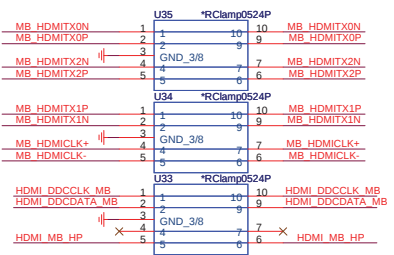
I2C



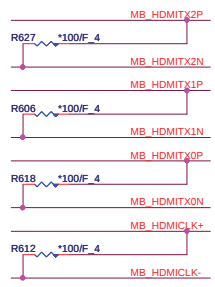
External Graphic HDMI source



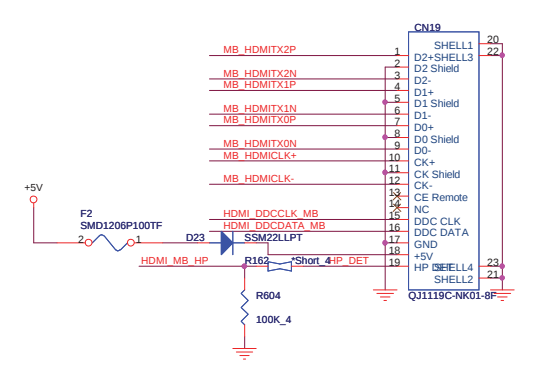
ESD Protect



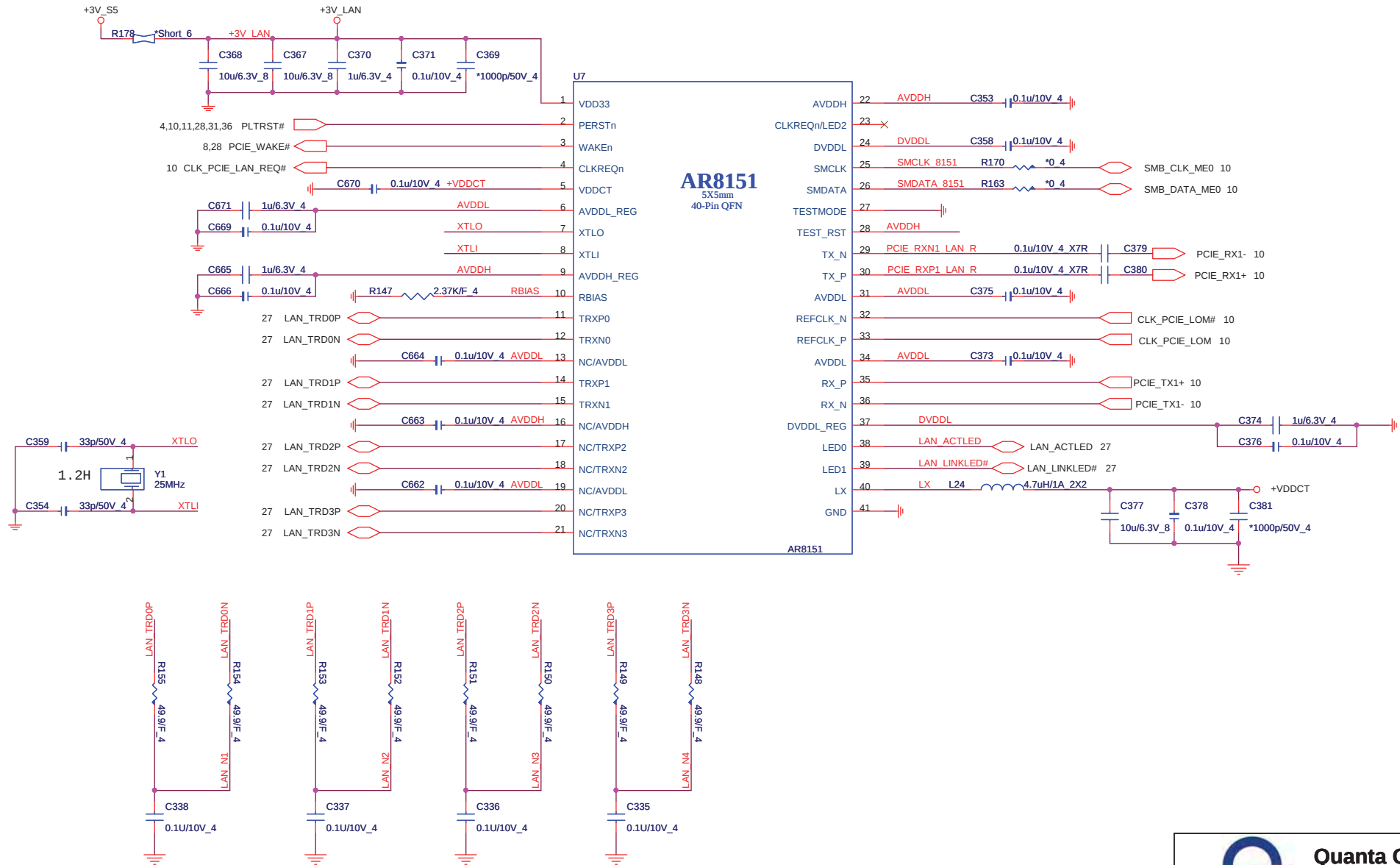
EMI

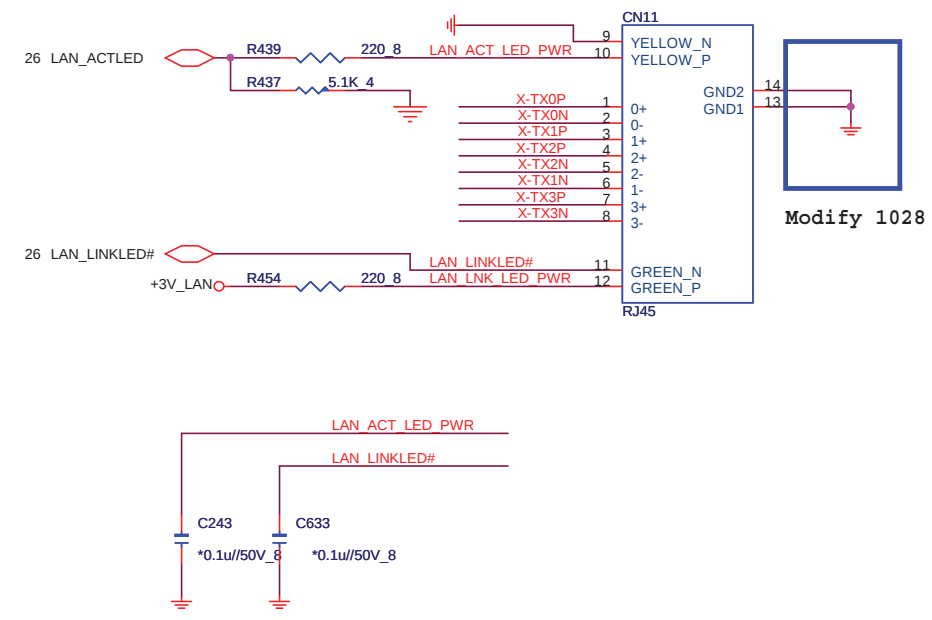
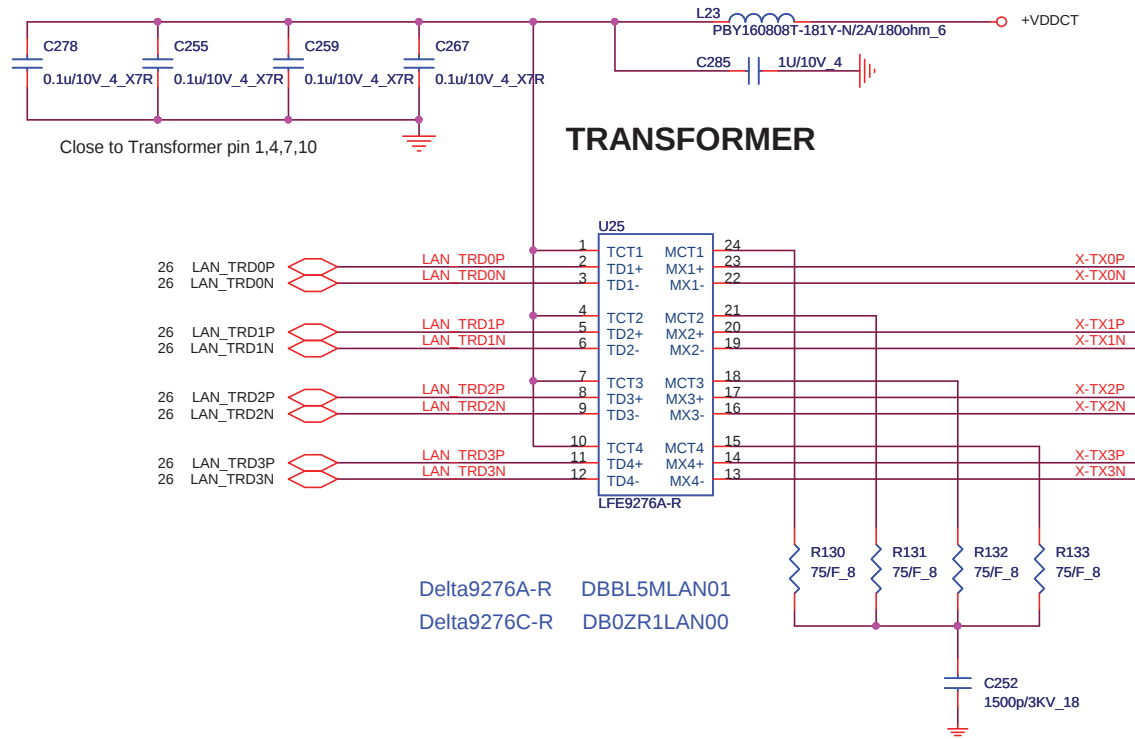


HDMI connector



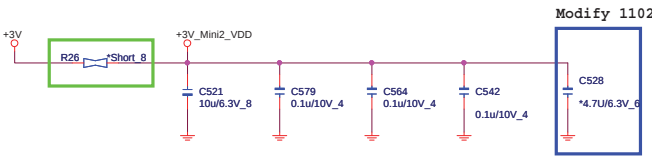
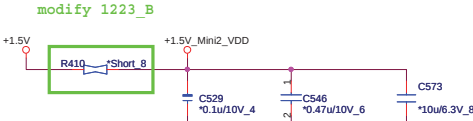
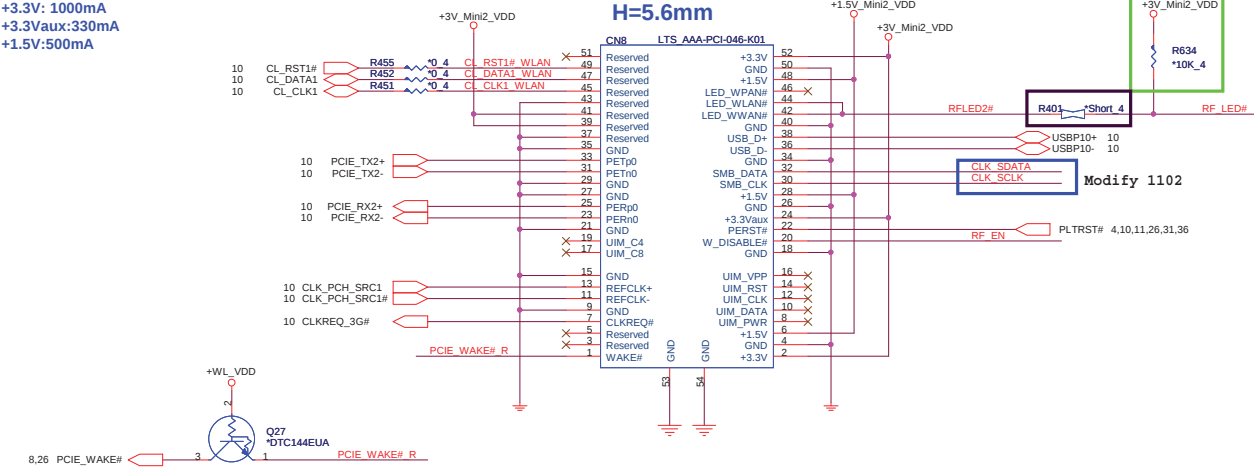
Giga-LAN AR8151





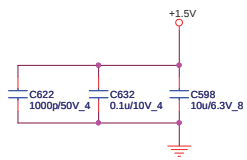
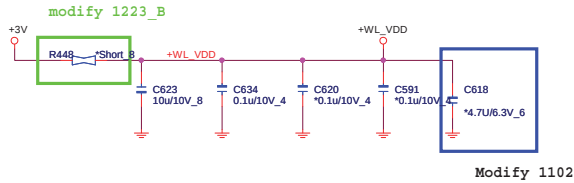
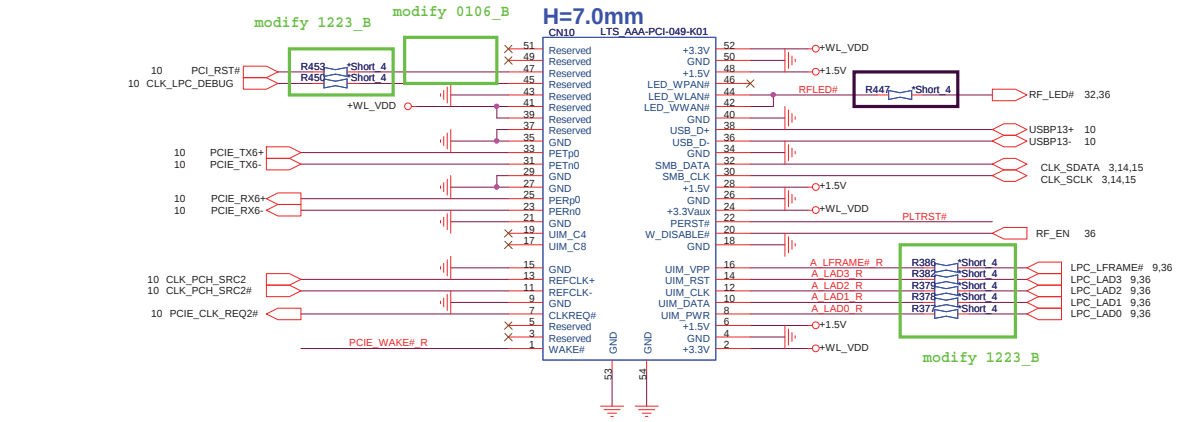
MINI-CARD WLAN(MPC)

+3.3V: 1000mA
+3.3Vaux:330mA
+1.5V:500mA

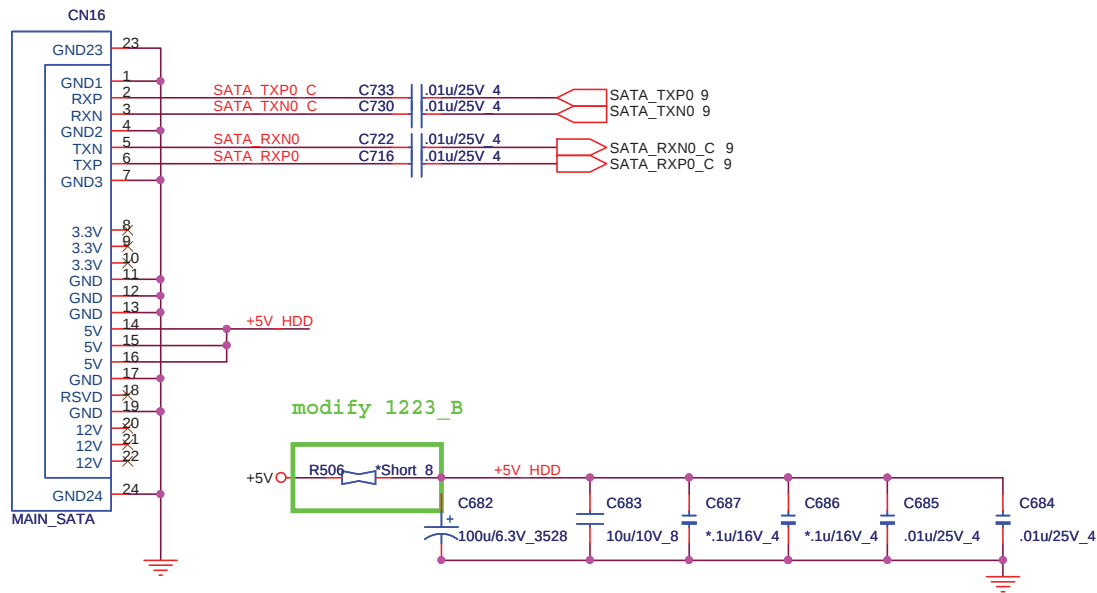


MINI-CARD (MNC)Reserve for BA70

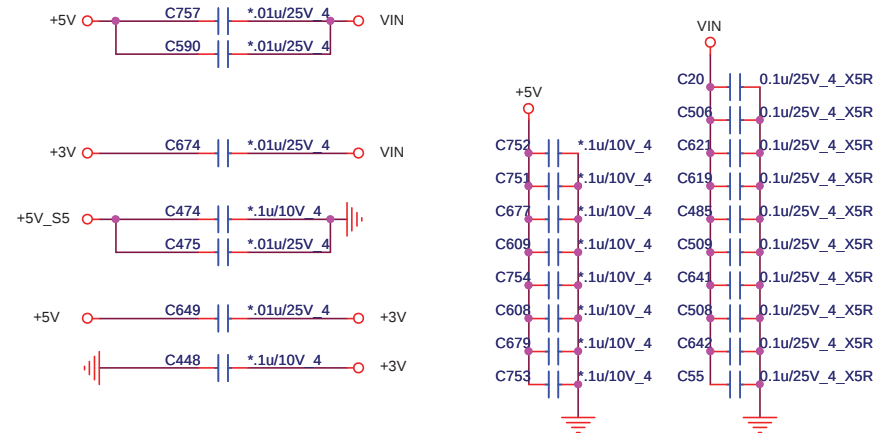
Check LED signal. (active high or low)



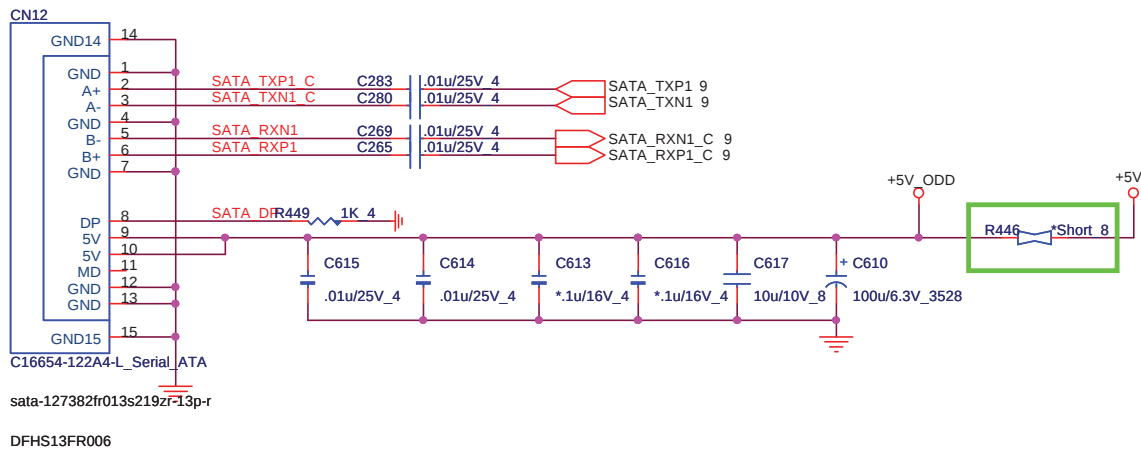
MAIN SATA HDD



EE RETURN-PATH CAPACITORS

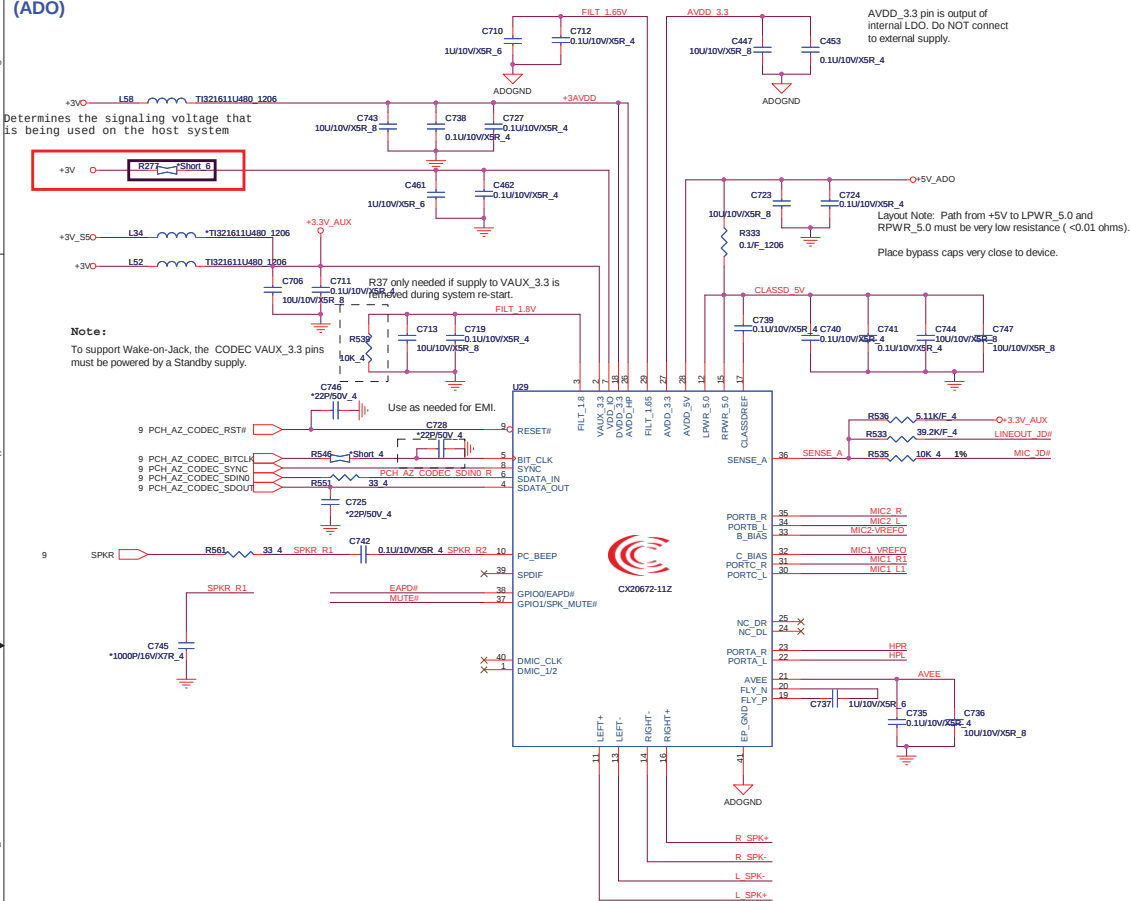


ODD (SATA)

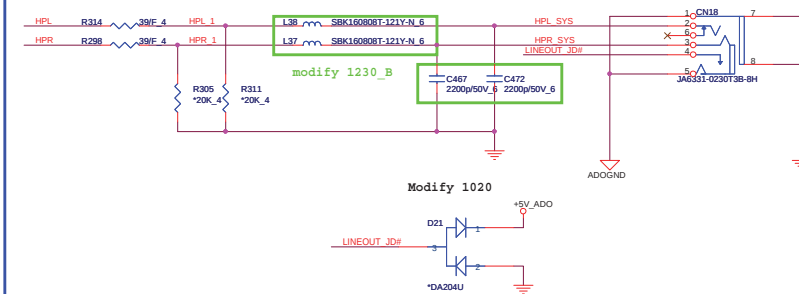


Codec(ADO)

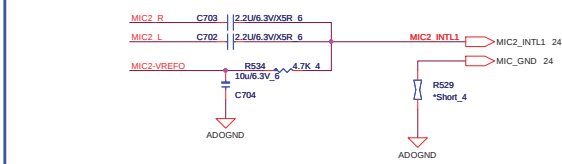
(CX20672-11Z for QFN)
(ADO)



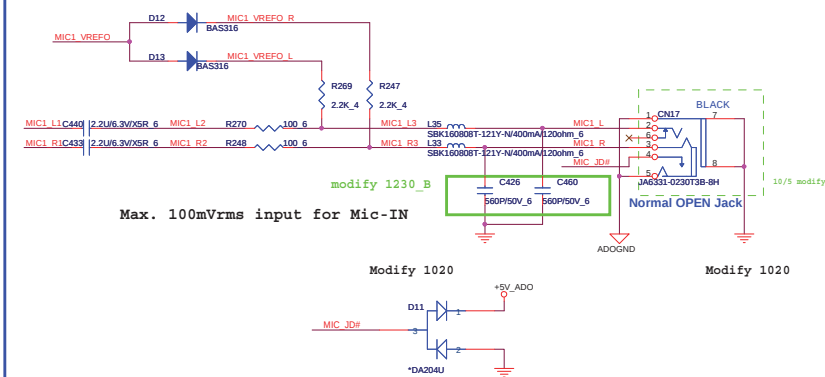
Headphone



INT. MIC

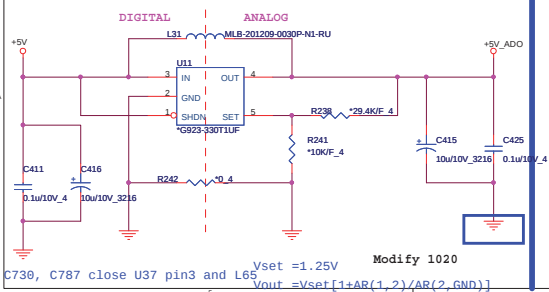


EXT. MIC

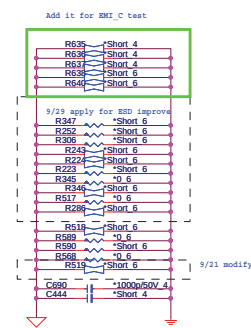
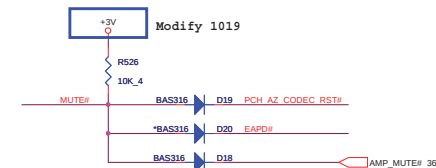


Power (ADO)

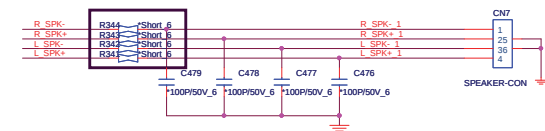
Demodulation Filter L65 Place close to Codec



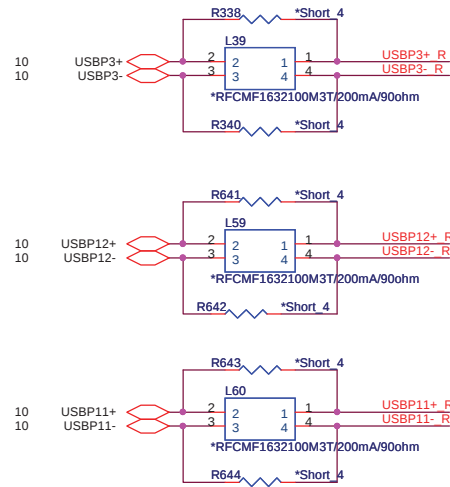
Mute(ADO)



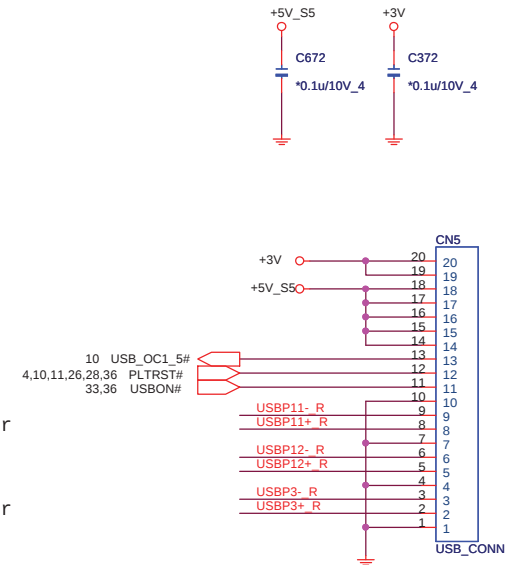
Internal Speaker(AMP)



Cardreader CONN(MMC)

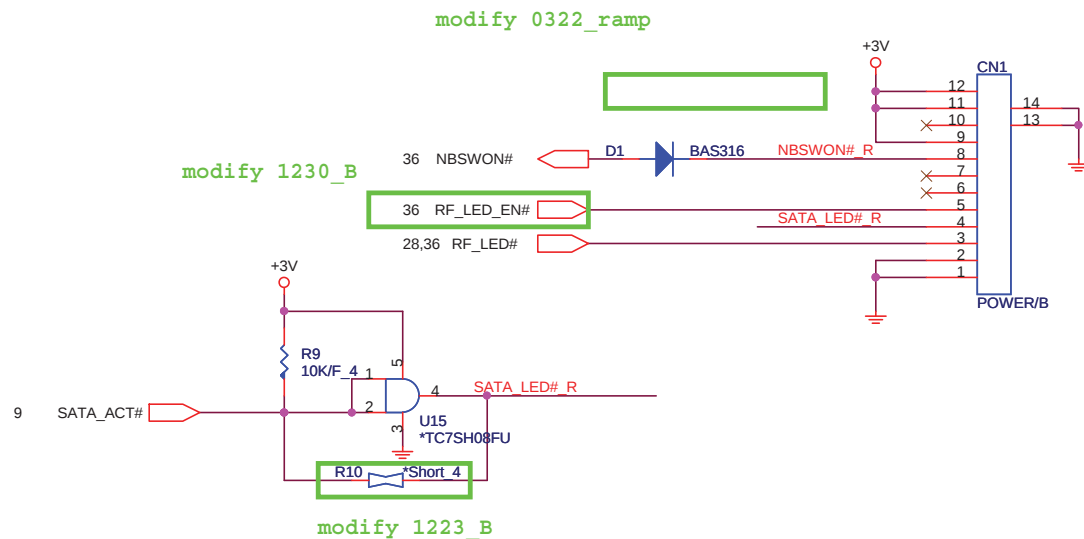


Amos 03/25

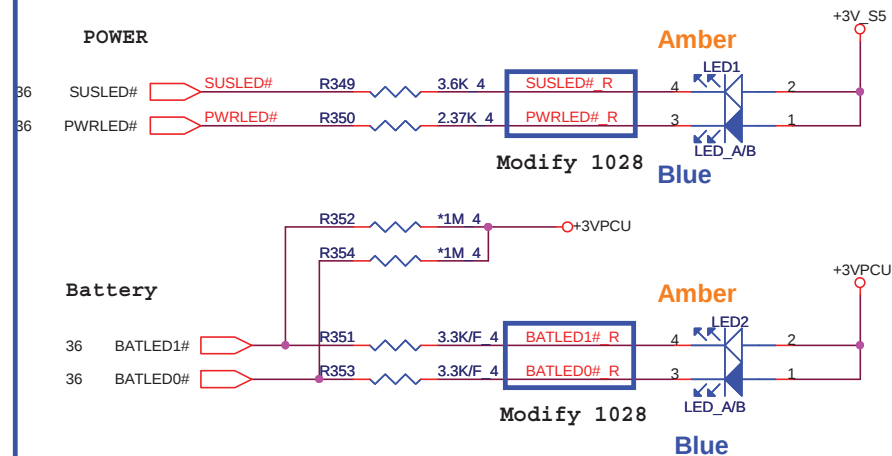


Modify 1028

POWER BOARD CONN(UIF)



LED(UIF)





10
10

USBP1-
USBP1+

L28

2 1
3 4

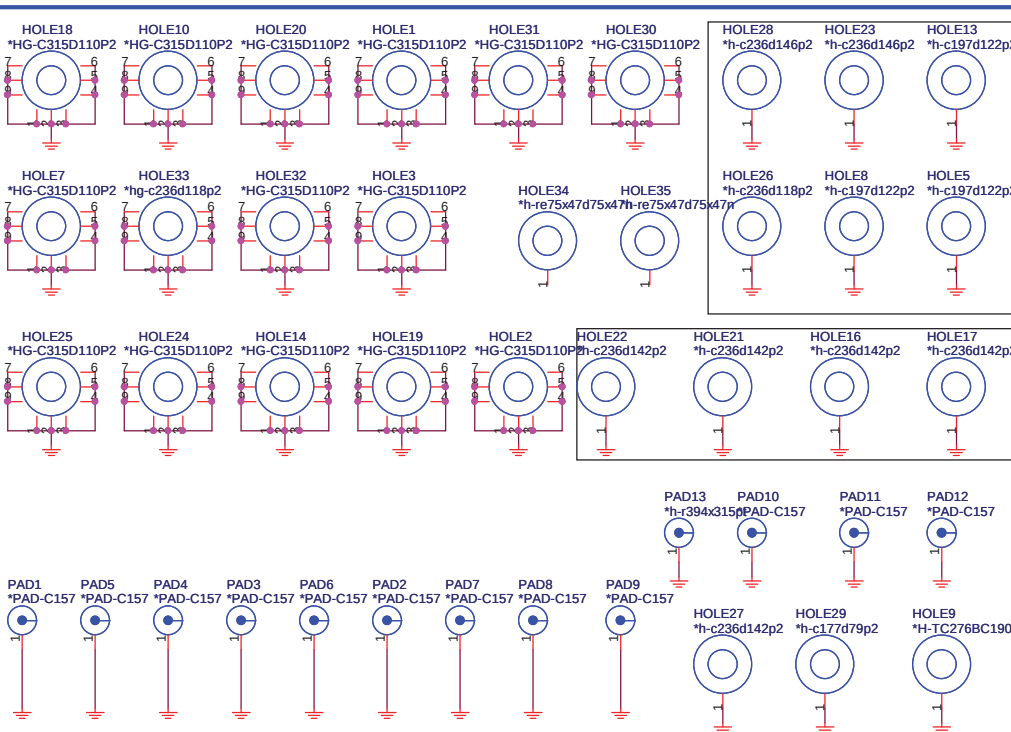
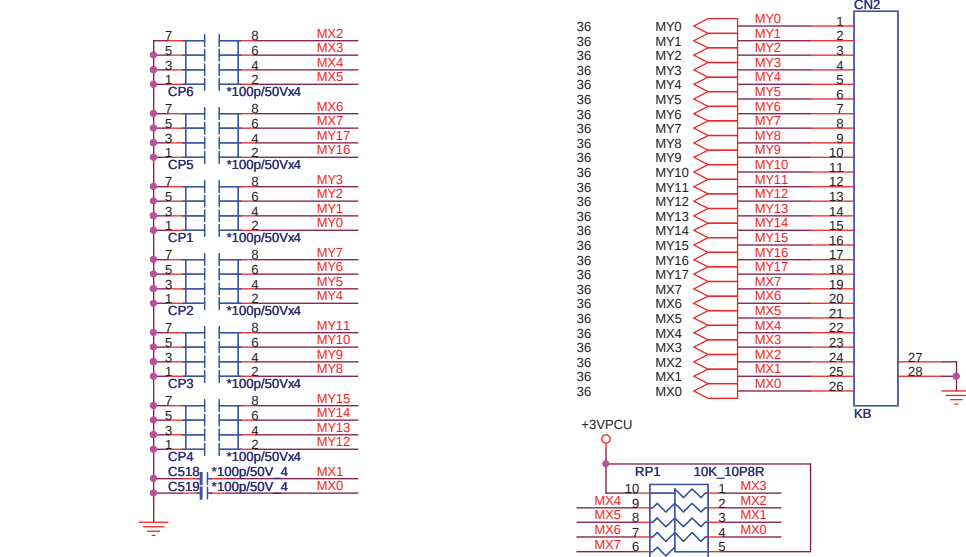
*RFCMF1632100M3T/200mA/90ohm

R195 *Short 4
R197 *Short 4

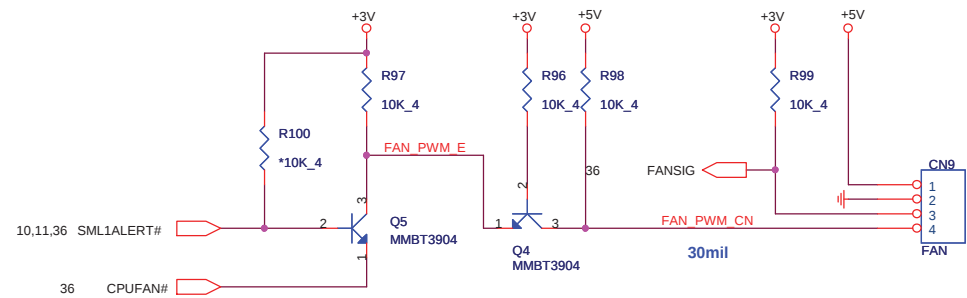
USBP1- R
USBP1+ R

Amos 03/25

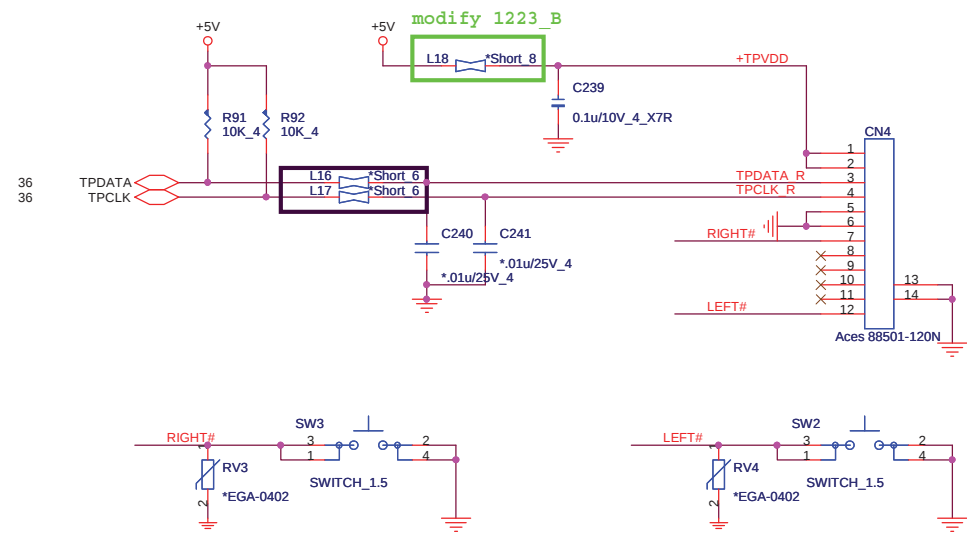
K/B



CPU FAN(THM)



TOUCHPAD & Switch CONN.(TPD)

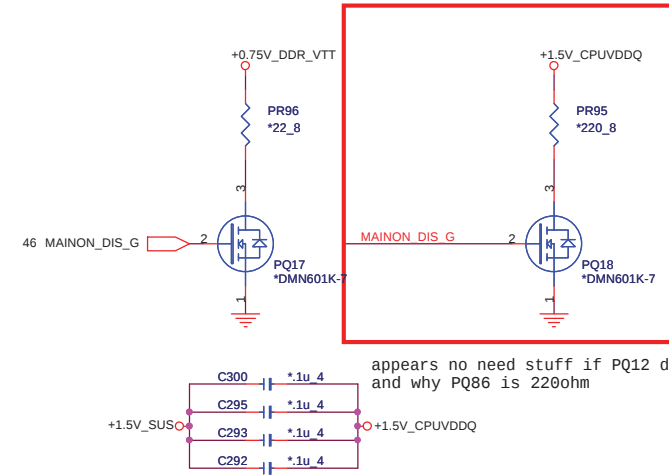


Quanta Computer Inc.

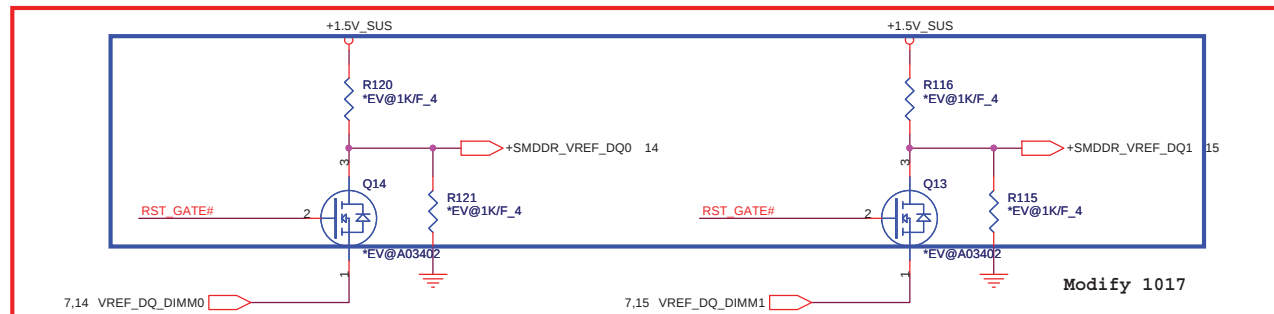
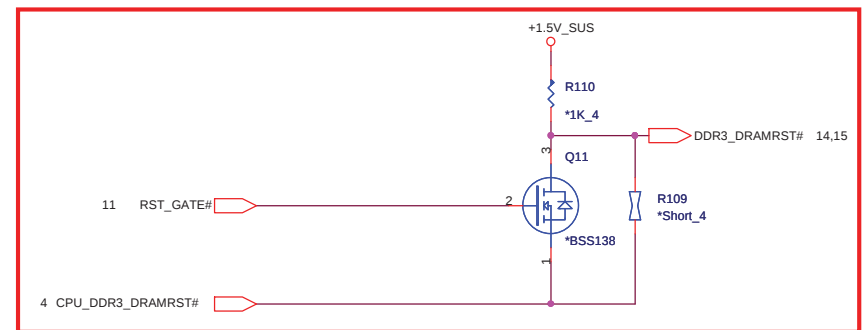
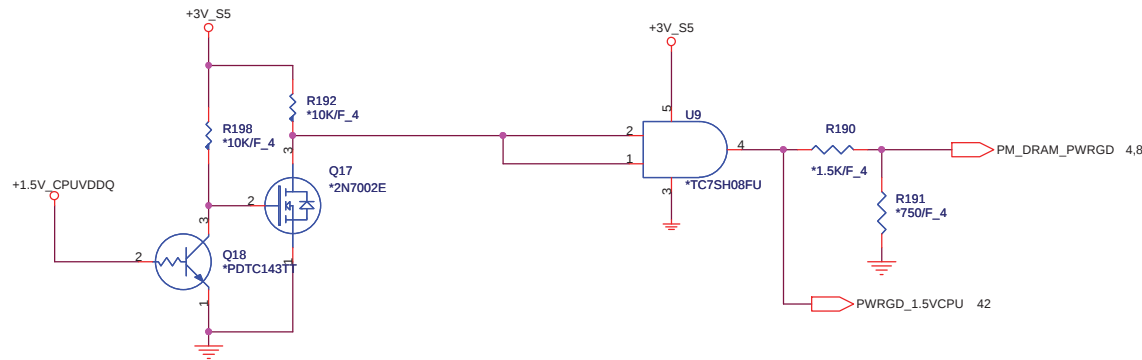
PROJECT : ZYD

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SM_DRAMRST# signal (to system memory) to be driven high
 CKE signals (to system memory) to be driven low
 VREFDQ and VREFCA voltage (on system memory) needs to be maintained
 1.5-V power rail to system memory to be maintained.
 All other DDR3 memory interface signals are don't care during S3 state for memory self refresh.
 SM_DRAMPWROK (to processor) is driven low during S3 as Processor VDDQ (1.5 V) is turned off with this implementation.

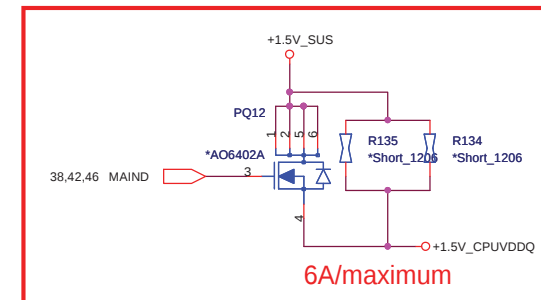


appears no need stuff if PQ12 don't stuff
 and why PQ86 is 220ohm



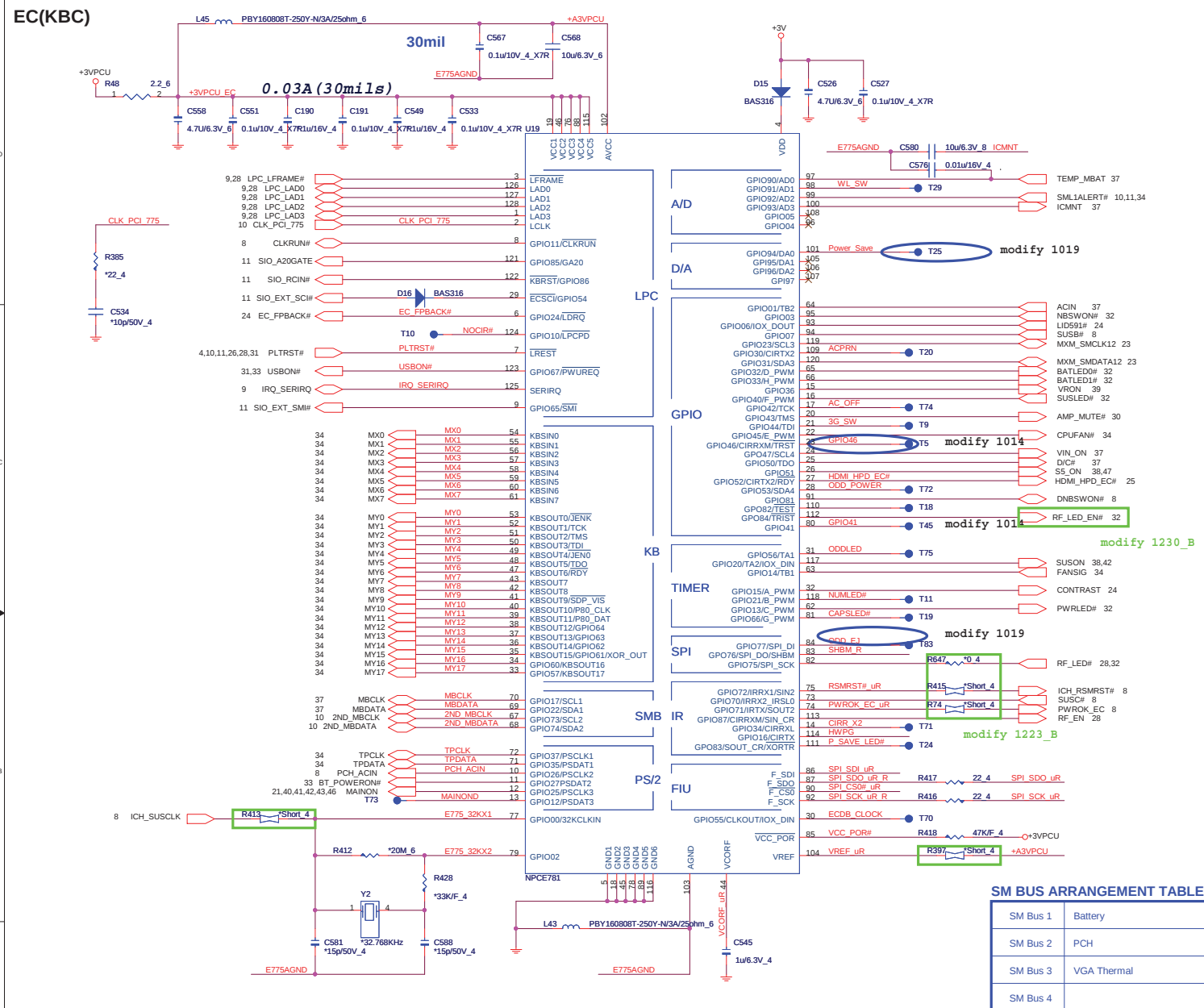
Modify 1017

These isolation FETs are not required for ARD-only designs. Only CFD and common motherboard designs need to implement this circuit to meet the DDR3 VREF specification during S3.



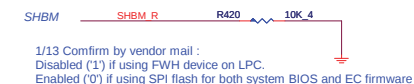
6A/maximum

EC(KBC)

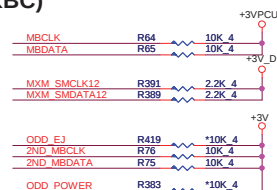


I/O ADDRESS SETTING(KBC)

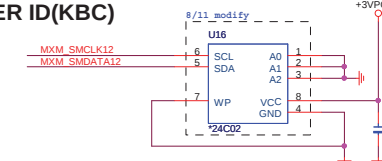
SHBM=0: Enable shared memory with host BIOS



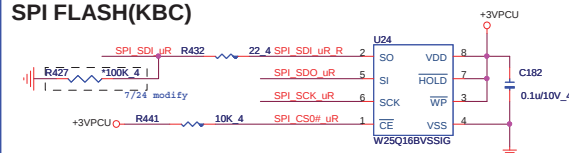
SM BUS PU(KBC)



ACER ID(KBC)



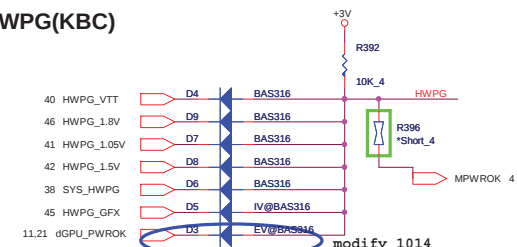
SPI FLASH(KBC)



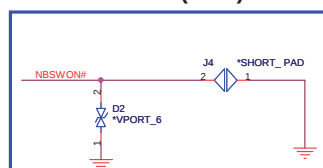
1/13 Confirm by vendor mail :
If the Southbridge enables 'Long Wait Abort' by default, the flash device should be 50MHz (or faster)

At 11/24 add	
Winbond W25X16AVSSIG	AKE38ZP0N01
MXIC MX25L1605AM2C-15G	AKE37FP0Z13
EON EN25F16-100HIP	AKE38ZA0Q00
AMIC A25L016	AKE38ZN0800

HWPG(KBC)



POWER-ON Switch(KBC)



Modifv 1028

INTERNAL KEYBOARD STRIP SET(KBC)

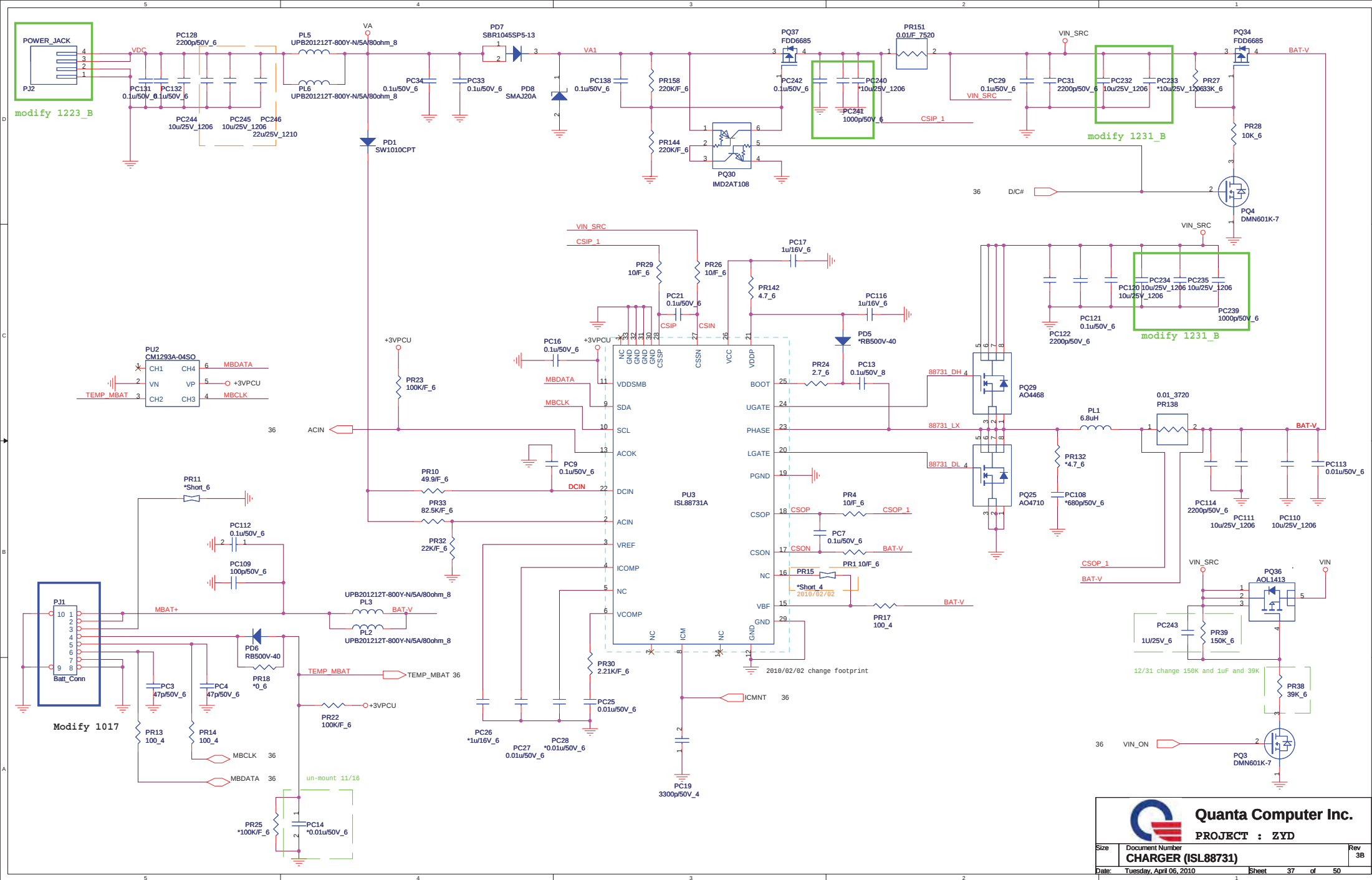
**Quanta Computer Inc.**

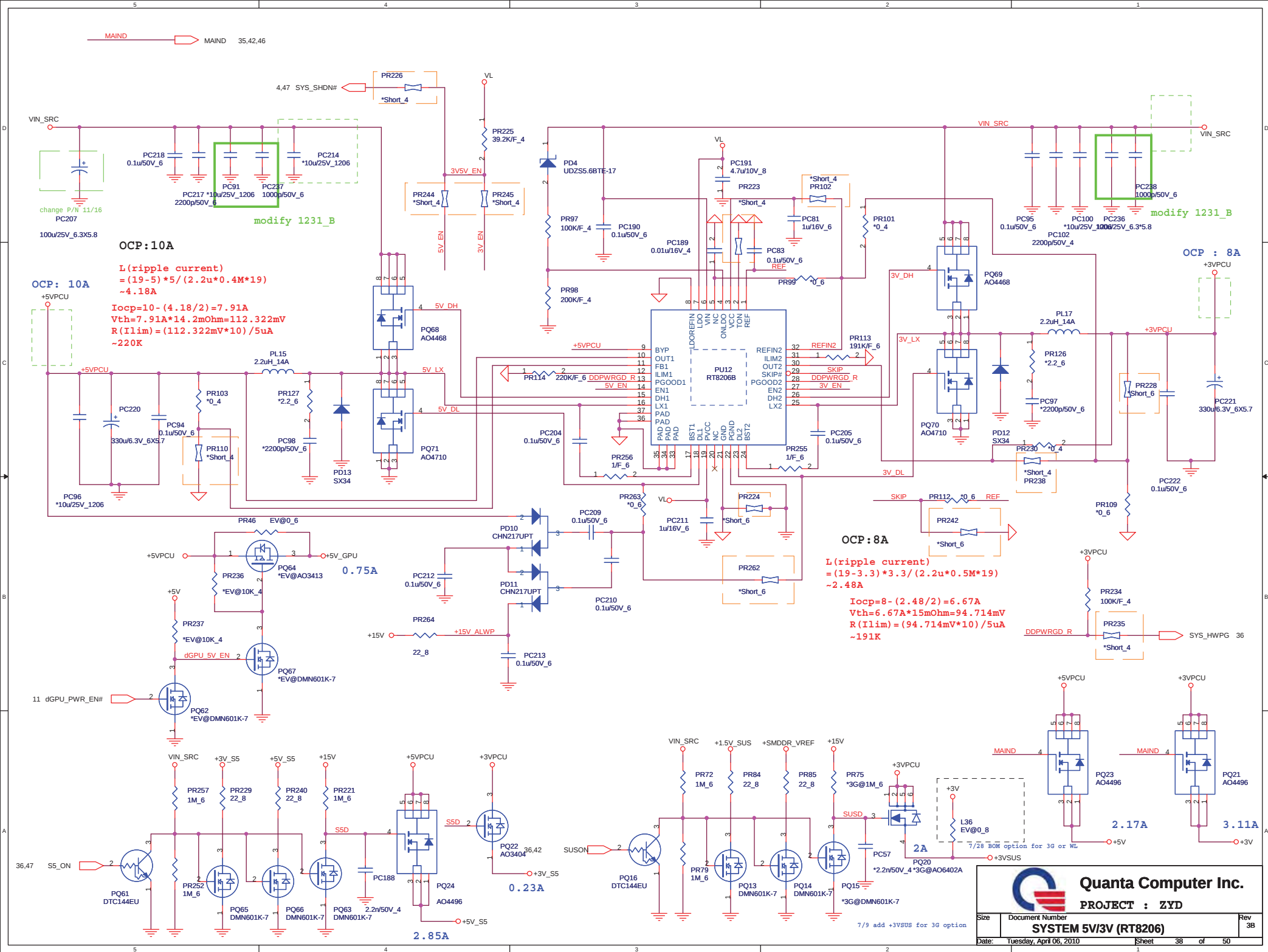
PROJECT : ZYD

WPCF781 & EL ASH

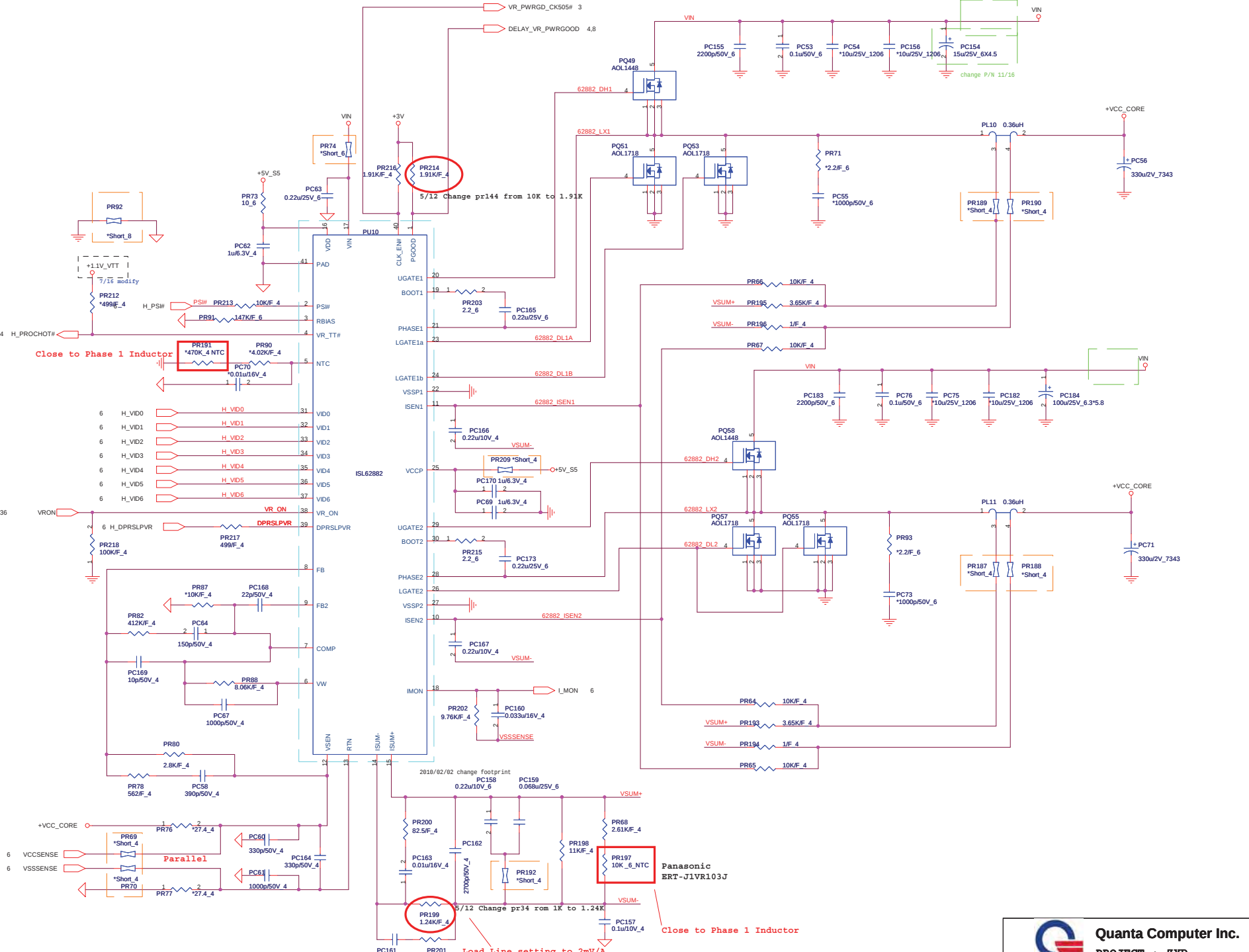
Size	Document Number
	WPCE781 & FLASH
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Date: Tuesday, April 06, 2010 Sheet 36 of 50

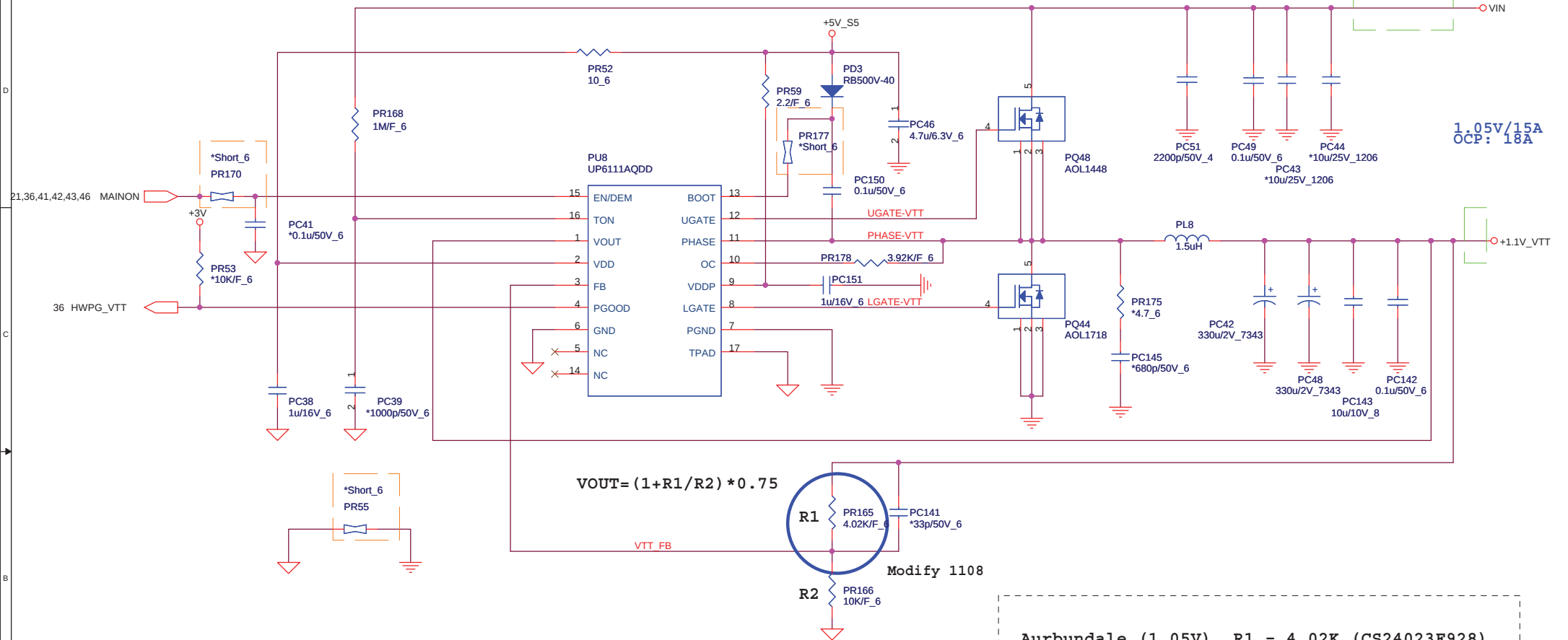




[PWM]



[PWM]



$$TON = 3.85p * RTON * Vout / (Vin - 0.5)$$

$$Frequency = Vout / (Vin * TON)$$

$$TON = 3.85p * 1M * 1 / (Vin - 0.5)$$

$$Frequency = 1 / (0.0036767) = 272K$$

AO1718 Rdson=3~4.3mOhm

$$L(ripple\ current) = (19 - 1.05) * 1.05 / (1u * 272k * 19) \sim 3.64A$$

$$4.3m * 18 = RILIM * 20uA$$

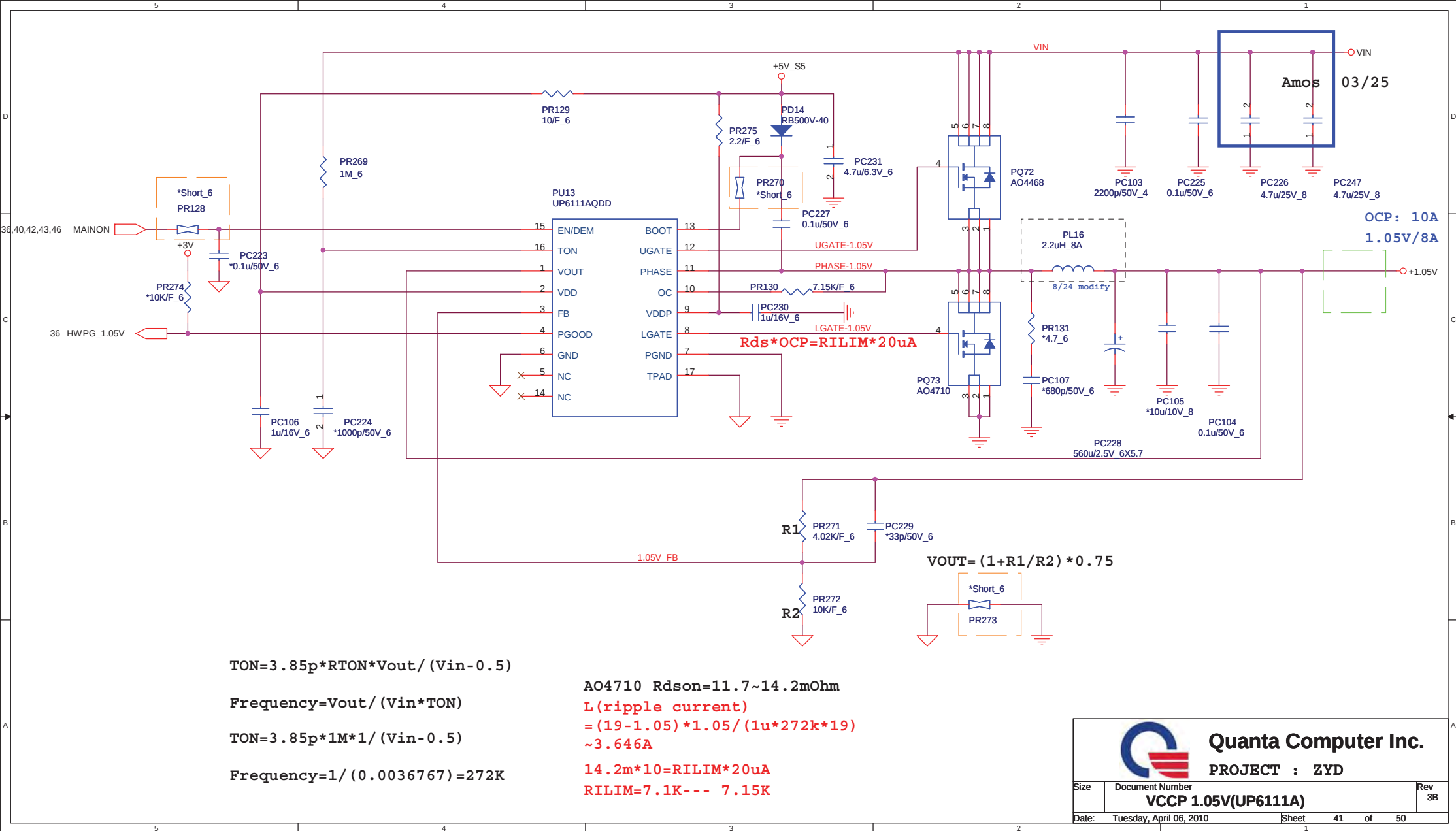
$$RILIM = 3.87K \text{ --- } 3.92K$$

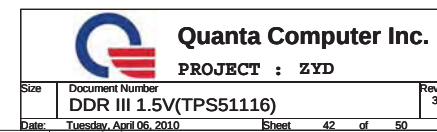
Aurbundale (1.05V) R1 = 4.02K (CS24023F928)
Clarksfield(1.1V) R1 = 4.75K (CS24753F919)

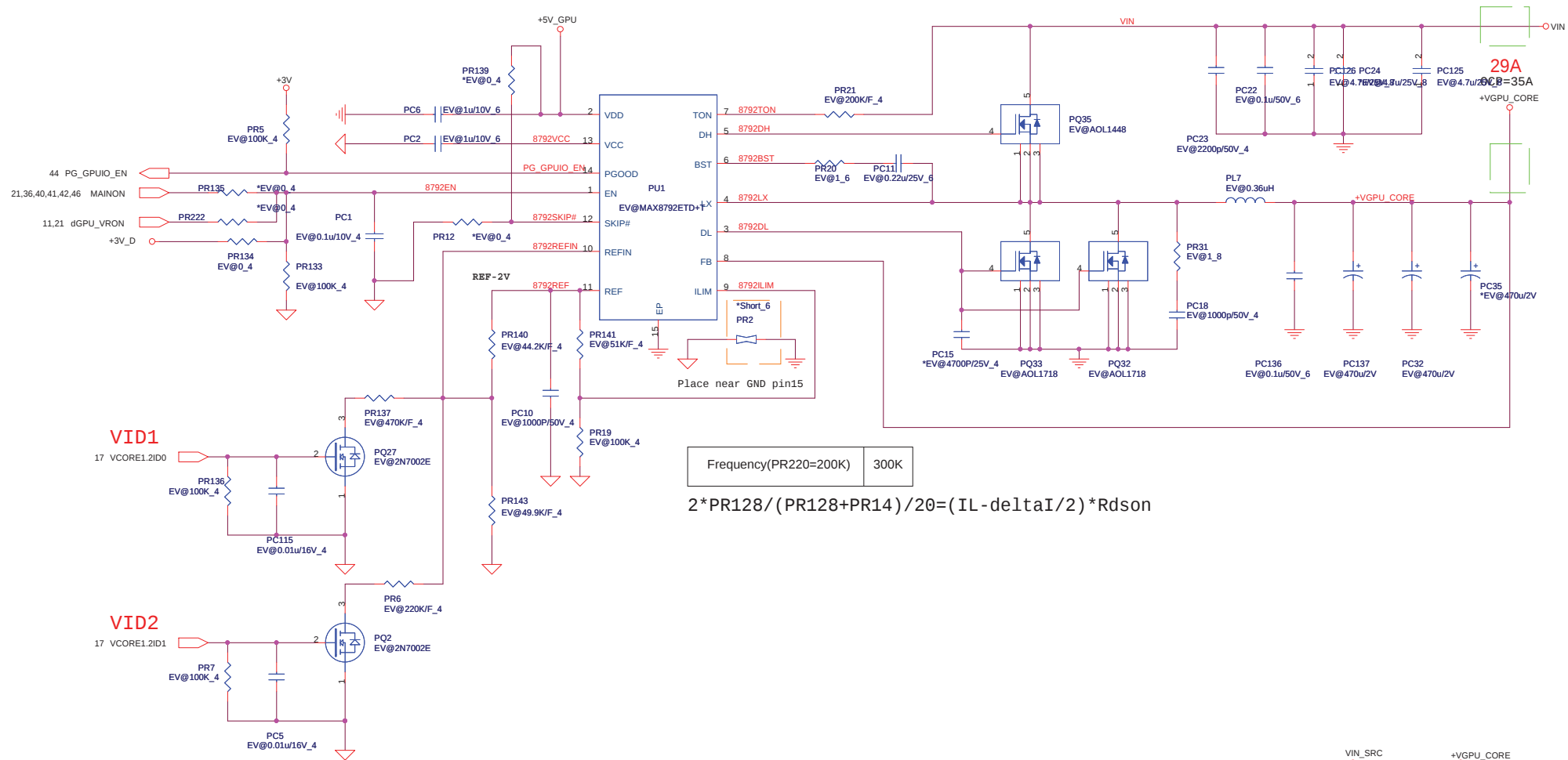


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PROJECT : ZYD

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	+VTT (UP6111A)	3B
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Madison VID Table

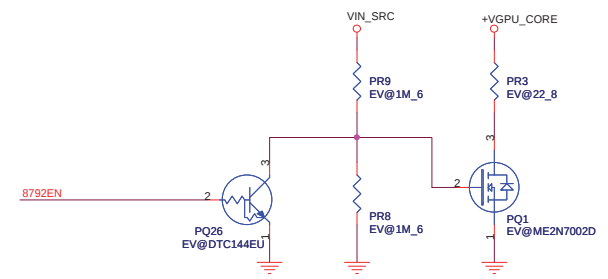
VID1	VID2		
VCORE1.2ID0	VCORE1.2ID1		+VCC_GFX_CORE
LOW (0)	LOW (0)		1.05V
HIGH (1)	LOW (0)		1.0V
LOW (0)	HIGH (1)		0.95V
HIGH (1)	HIGH (1)		0.90V

PR140 = 44.2K
PR143 = 49.9K
PR137 = 470K
PR6= 220K

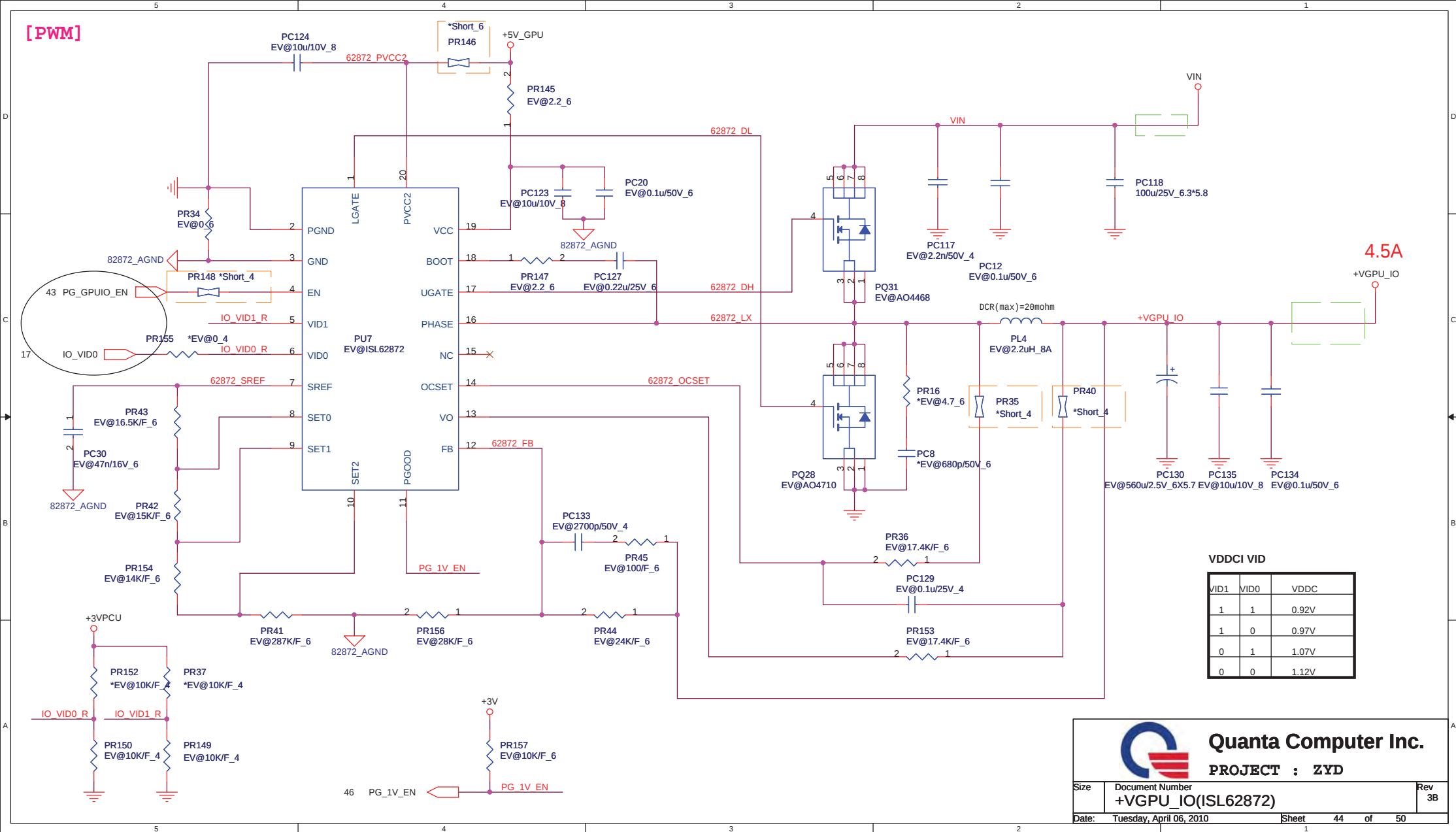
PARK XT VID Table

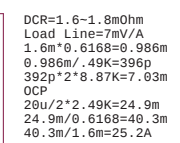
VID1	VID2		
VCORE1.2ID0	VCORE1.2ID1		+VCC_GFX_CORE
LOW (0)	LOW (0)		1.12V
HIGH (1)	LOW (0)		1.05V
LOW (0)	HIGH (1)		0.95V
HIGH (1)	HIGH (1)		0.90V

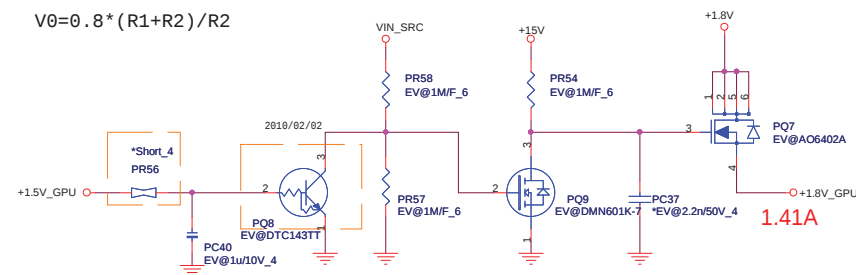
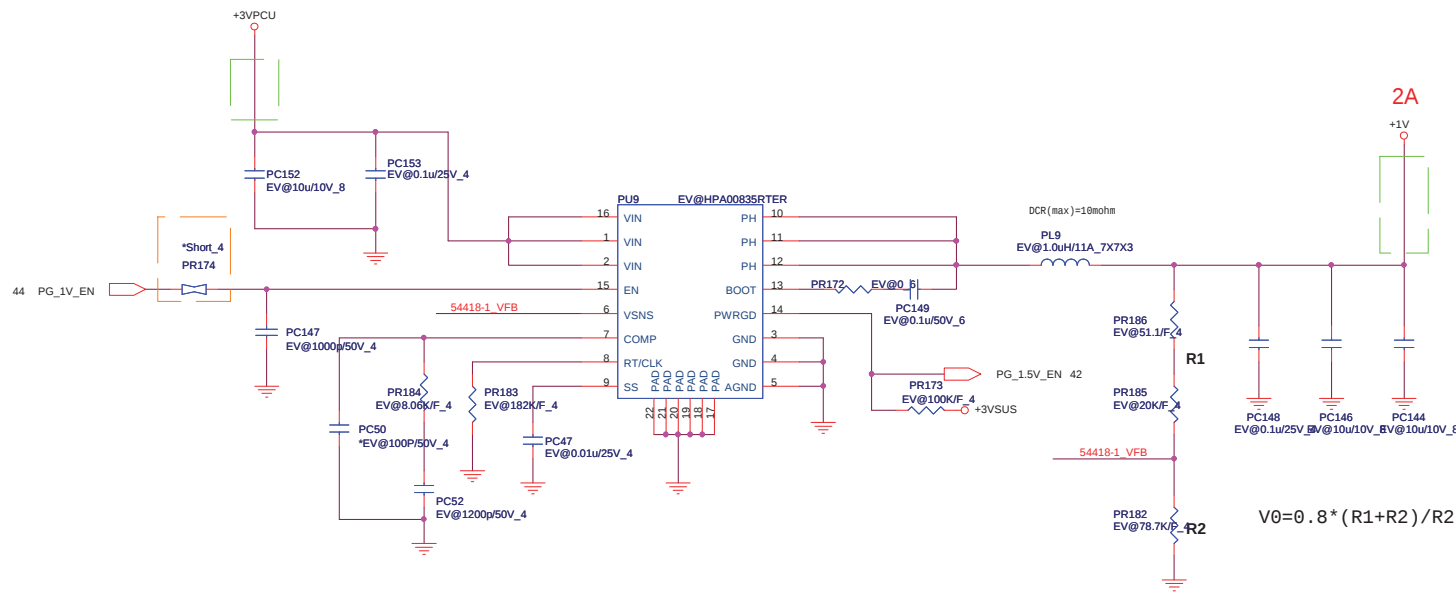
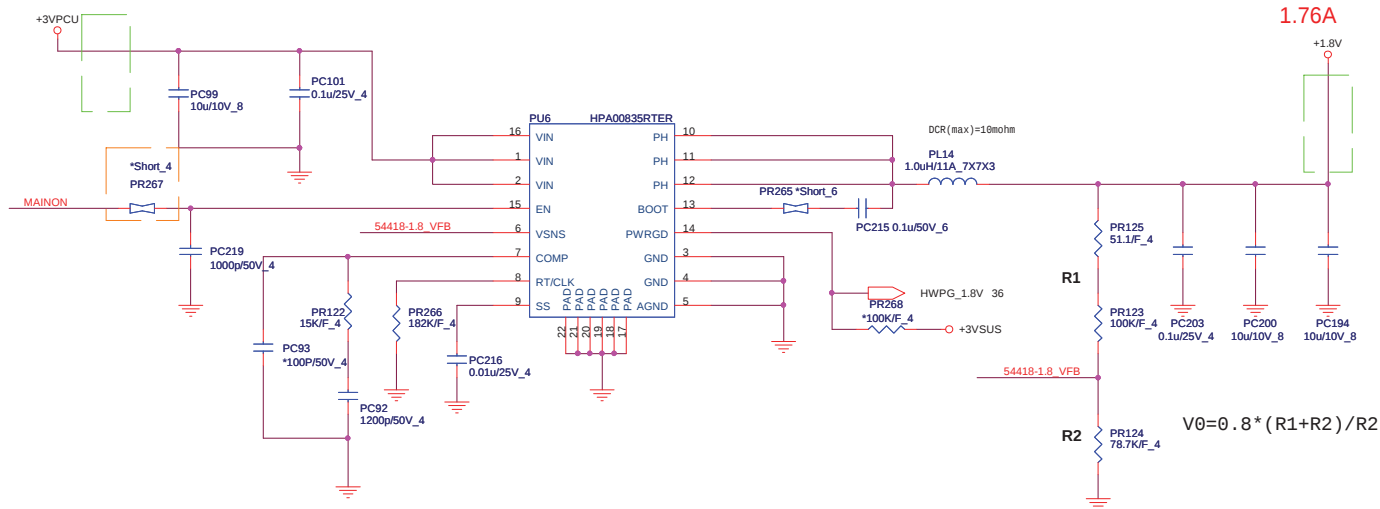
PR140= 39.2K CS33922FB15
PR143 = 49.9K CS43322FB15
PR137 = 332K CS41302FB00
PR6 = 130K



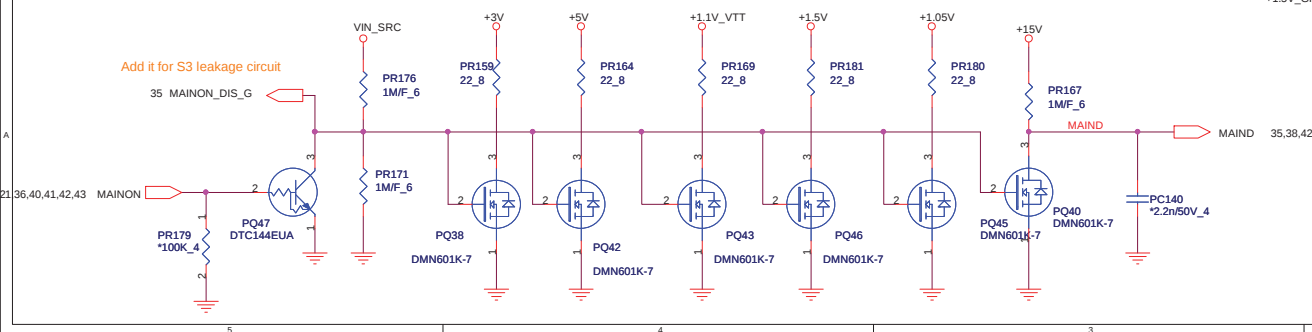
[PWM]



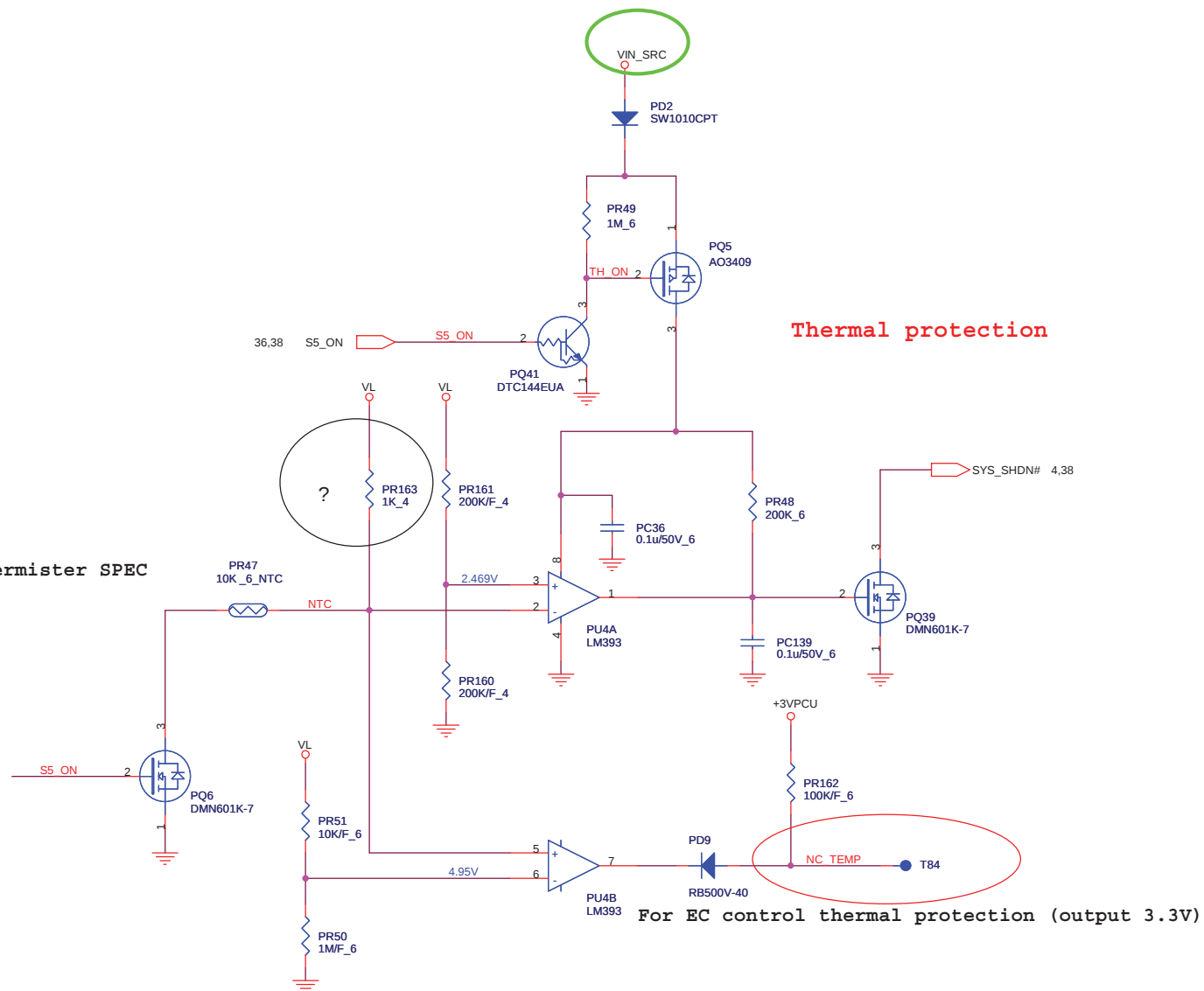




Add it for S3 leakage circuit



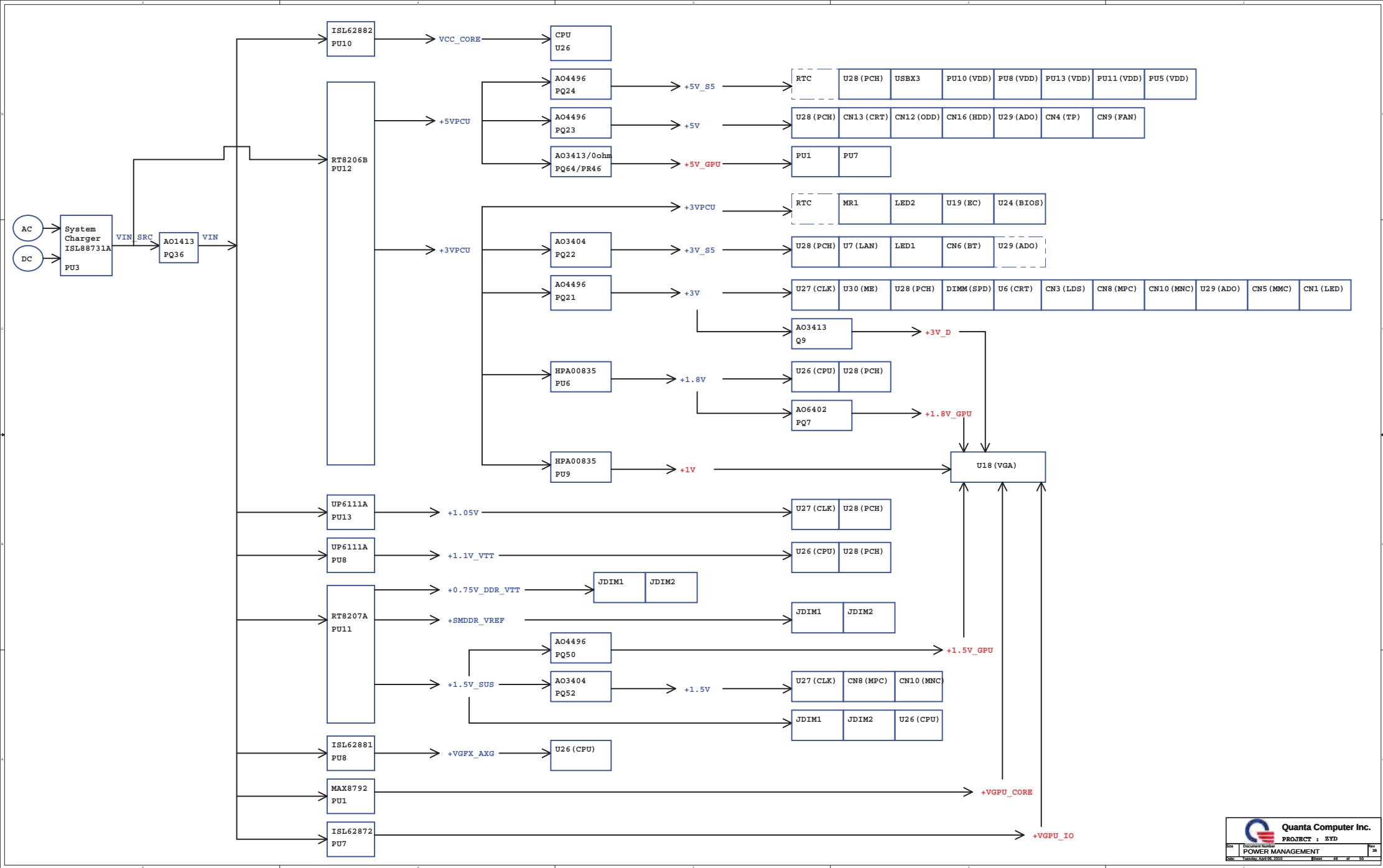
based on thermister SPEC
1K--->82~83



Quanta Computer Inc.

PROJECT : ZYD

Size	Document Number	Rev
	Thermal Protection	3B
Date:	Tuesday, April 06, 2010	Sheet 47 of 50



Model	REV	CHANGE LIST	MODEL	ZYD	
ZYD MB	1A	20091020 Page 30, Move the resistors and common chokes from M/B to daughter board		FROM	To
		20091020 Page 30, Move the R1027 and R1059 to daughter board and change to 0402 (place closer).		X	1A
		20091020 Page 30, Move USB Power switch to daughter board		X	1A
		20091020 Page 30, Change card reader+USB board CONN P/N to DFPC209F0255		X	1A
		20091020 Page 26, Delete R203 and R171 to leave RJ45 chassis contact to GND directly		X	1A
		20091020 Page 31, Add net name susledw_R, Pwledw_R,BATLED0w_R, BATLED1w_R,RFLEDw_R,RFLED2w_R		X	1A
		20091020 Page 35, Add SW1 for debug purpose		X	1A
		20091020 Page 33, update Hole footprints		X	1A
		20091029 Page 41, Change PR109, PR200 P/N from C500003J951 to C500003F916		X	1A
		20091102 Page 24, 29, Add Mic_GND for internal analog MIC		X	1A
	2A	20091102 Page 27, Delete C204, C208, C558, R411, R385, R373, RP3, Q27, Q26. and change C578 from 0.47u to 4.7u		X	1A
		20091102 Page 10, Stuff R1001, R1002, R503		X	1A
		20091103 Page 33, Delete Hole4, Hole5, Hole6, Hole18		X	1A
		20091104 Page 33, update power schematic		X	1A
		20091104 Page 30, swap L38,L39,L58 USB nets for layout request.		X	1A
		20091108 Page 45, delete net name MAIN0M_G		X	1A
		20091108 Page 39, Change PR151 P/N from CS24703F900 to CS24023F920 for support Arrandale only		X	1A
		20091108 Page 33, Delete Hole36		X	1A
		20091110 Page 31, Move Wi-Fi LED to PB		X	1A
		20091111 Page 39, Delete P18 and Change P19 footprint and value(1.5uH footprint:CHOKE-ETQP4LR3GWFC-NB4)		X	1A
	3A	20091111 Page 41, Stuff +1.5V_GPU power source for EV0 only		X	1A
		20091111 Page 37, reserve PR275 for GPU power		X	1A
		20091112 Page 18, Follow ATI suggestion to modify R419 from 680ohm to 51 ohm.		X	1A
		20091112 Page 27, Remove LPC from Mini PCIE port CN24		X	1A
		20091112 Page 37,45, unstuff +3V_SUS components		X	1A
		20091113 Page 27, Two Wi-Fi LED share one net RF_LEDW		X	1A
		20091113 Page 31, Delete Q21,Q23, R347		X	1A
		20091113 Page 29, Reserve three more resistors R373, R368, R385 for ESD solution		X	1A
		20091116 Page 34, unstuff PR95, PR96, PQ17, PQ15		X	1A
		20091116 Page 24, Change C650 from 0.22u/6.3V_4 to 0.22u/10V_4		X	1A
		20091116 Page 32, Change C399 from 1u/6.3V_4 to 1u/10V_4		X	1A
		20091116 Page 7, unstuff R159		X	1A
		20091116 Page 11, stuff R592 for DIS and stuff R595 for UMA		X	1A
		20091116 Page 11, Reserve pull low for unused pin dGPU_VMON_R		X	1A
		20091116 Page 8, Delete R414		X	1A
		20091116 Page 25, Delete R162		X	1A
		20091116 Page 36-45, PC14 un-mount; PC207 change P/N; PC154 change P/N and value.; PC155 un-mount; PC180 change P/N; PC119 change P/N; PC118 change P/N		X	1A
		20091119 Page 36, Modify Bat CONN P/N and footprint		1A	2A
		20091119 Page 29, Modify Speaker CN7 P/N from DFHD04MR779 to DFHD04MR057		1A	2A
		20091120 Page 8'13, Modify PCH P/N from A30QMCS0T05 to A3SLGZS0T07		1A	2A
		20091124 Page 27, Short Pin42 and Pin44 of CN8 and CN10 to support Intel WiMAX/WiFi combo module		1A	2A
		20091128 Page 37, stuff L36 for discrete sku		1A	2A
		20091128 Page 9, change U30(ME ROM) P/N from AKE391P0N00 to AKE38ZP0N01		1A	2A
		20091202 Page 3, reserve 1U for CLK GEN +1.5V power		1A	2A
		20091203 Page 27, Stuff Q26 and Q28; unstuff R401 and R447; and add LPC bus to CN24 for debug purpose		1A	2A
		20091209 Page 42, add VID table for Park XT		1A	2A
		20091209 Page 3, change R257 from 0ohm to 33ohm		1A	2A
		20091209 Page 3,17,18 follow AMD suggestion to stuff R257, R101, R407,R409 and remove R36 to fix AMD pre-production silicon bug		1A	2A
		20091214 Page 9, change R317 to a JP and stuff R322		1A	2A
		20091214 Page 32, change CN6 from DFHD05MR098 to DFWF05MR027		1A	2A
		20091221 Page 29, change R533 from C503923F916 to CS33922F815		1A	2A
		20091223 Page 10, change R202, R203, R540, R566, R547 to short pad		1A	2A
		20091223 Page 36, change DC jack P/N to DFHS04FR741		1A	2A
		20091223 Page 32, change CN6 P/N to DFWF05MR012		1A	2A
		20091225 Page 50, change CN19 P/N to DFHD19MR083		1A	2A
		20091230 Page 12, Add C786 for CRT flicker issue		1A	2A
		20091230 Page 27, change transformer footprint to TRF-10-1-24P-SMT		1A	2A
		20091230 Page 17, change VGPU_CORE VID control pin		1A	2A
		20091230 Page 28, Exchange P/N for cn8 and cn10		1A	2A
		20091230 Page 28, Move controller link from CN10 to CN8		1A	2A
		20100129 Page 32, remove power LED MOS Q25		2A	3A
		20100130 Page 18, Remove AMD option 2 workaround for Madison and Park; and change R36 from 1K to 10K		2A	3A
		20100130 Page 28, Change Mini card footprint to MIPCI-000055FB052GX-52P-LDV-NB4		2A	3A
		20100201 Page 32, restore power LED MOS Q25		2A	3A
		20100201 Page 25, Change Q33,Q34 to ESD protection part		2A	3A
		20100222 Page 24, Reserve C787 and C788 for CRT flicker issue		2A	3A
		20100222 Page 36, Remove SW1		2A	3A
		20100222 Page 12, Add C789 for VCCADAC		2A	3A
		20100222 Page 17, Reserve 10uF2 caps for +1.5V_GPU		2A	3A
		20100222 Page 30, Add short Pad R635,R636,R637,R638,R640 for DM1		2A	3A
		20100222 Page 24, unstuff L13 and stuff R89 and R90		2A	3A

Model		REV	CHANGE LIST				MODEL	ZYD	
ZYD MB		3B	20100322 Page 32, delete Q25 20100322 Page 44,45 modify PU5,PU7 footprint 20100324 Page 44,45 change PC184,PC179,PC207,PC125,PC236,PC118,PC186 P/N to CC71004M204 20100324 Page 43 change PC126, PC24, PC125 to CH5474KEA06(4.7uF 25V 0805) 20100324 Page 30 change R298,R314 to 39ohm 20100325 reserved EMI chock lacion for USB 1/3/11/12/8 20100325 Page 41 change PC226 to 0805 4.7uF/25V,and add PC247 ,BOM stuff. 20100325 Page 30 change R223,R347,C444,R252, R590 and R306 to short pad.				FROM	To	
							3A	3B	
							3A	3B	
							3A	3B	
							3A	3B	
							3A	3B	
							3A	3B	
							3A	3B	
							3A	3B	
							3A	3B	
							3A	3B	
							3A	3B	
							3A	3B	
DOC NO.		PROJECT MODEL :		ZYD	APPROVED BY:	DATE:	2010/3/25		
PART NUMBER:					DRAWING BY:	REVISION:	3B		